



## Automotive: CY8C27243, CY8C27443, and CY8C27643

### Features

#### ■ Powerful Harvard Architecture Processor

- M8C Processor Speeds to 12 MHz
- 8x8 Multiply, 32-Bit Accumulate
- Low Power at High Speed
- 4.75V to 5.25V Operating Voltage
- Extended Temp. Range: -40°C to +105°C

#### ■ Advanced Peripherals (PSoC Blocks)

- 12 Rail-to-Rail Analog PSoC Blocks Provide:
  - Up to 14-Bit ADCs
  - Up to 9-Bit DACs
  - Programmable Gain Amplifiers
  - Programmable Filters and Comparators
- 8 Digital PSoC Blocks Provide:
  - 8- to 32-Bit Timers, Counters, and PWMs
  - CRC and PRS Modules
  - Up to 2 Full-Duplex UARTs
  - Multiple SPI™ Masters or Slaves
  - Connectable to all GPIO Pins
- Complex Peripherals by Combining Blocks

#### ■ Precision, Programmable Clocking

- Internal ±4% 24 MHz Oscillator
- 24 MHz with Optional 32.768 kHz Crystal
- Optional External Oscillator, up to 24 MHz
- Internal Oscillator for Watchdog and Sleep

#### ■ Flexible On-Chip Memory

- 16K Bytes Flash Program Storage
- 256 Bytes SRAM Data Storage
- In-System Serial Programming (ISSP)
- Partial Flash Updates
- Flexible Protection Modes

#### ■ Programmable Pin Configurations

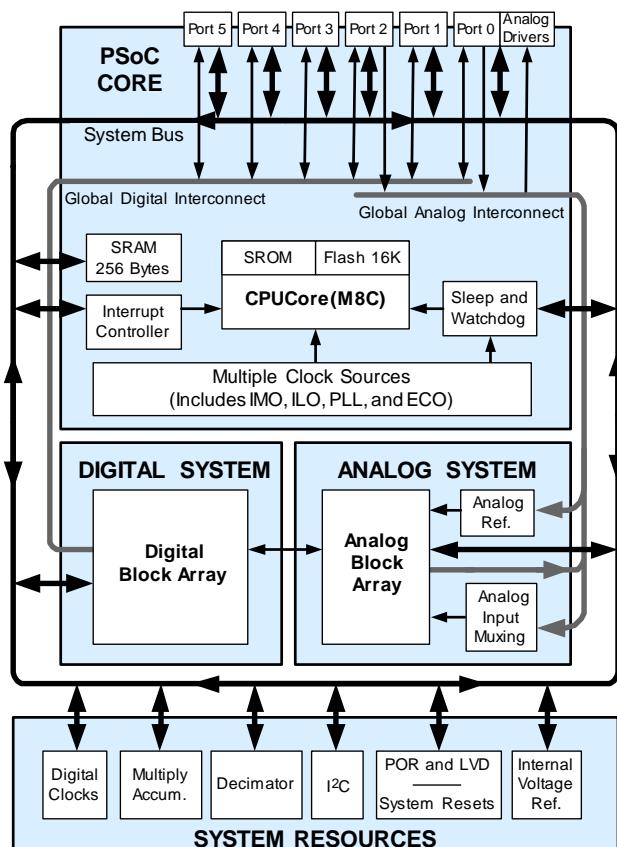
- 25 mA Sink on All GPIO
- Pull Up, Pull Down, High Z, Strong, or Open Drain Drive Modes on all GPIO
- Up to 12 Analog Inputs on GPIO
- Four 30 mA Analog Outputs on GPIO
- Configurable Interrupt on All GPIO

#### ■ Additional System Resources

- I<sup>2</sup>C™ Slave, Master, and Multi-Master to 400 kHz
- Watchdog and Sleep Timers
- User-Configurable Low Voltage Detection
- Integrated Supervisory Circuit
- On-Chip Precision Voltage Reference

#### ■ Complete Development Tools

- Free Development Software (PSoC™ Designer)
- Full-Featured, In-Circuit Emulator and Programmer
- Full Speed Emulation
- Complex Breakpoint Structure
- 128K Bytes Trace Memory



### PSoC® Functional Overview

The PSoC® family consists of many *Mixed-Signal Array with On-Chip Controller* devices. These devices are designed to replace multiple traditional MCU-based system components with one, low cost single-chip programmable device. PSoC devices include configurable blocks of analog and digital logic, as well as programmable interconnects. This architecture allows the user to create customized peripheral configurations that match the requirements of each individual application. Additionally, a fast CPU, Flash program memory, SRAM data memory, and configurable IO are included in a range of convenient pinouts and packages.

The PSoC architecture, as illustrated on the left, is comprised of four main areas: PSoC Core, Digital System, Analog System, and System Resources. Configurable global busing allows all device resources to be combined into a complete custom system. The CY8C27x43 automotive family can have up to five IO ports that connect to the global digital and analog interconnects, providing access to 8 digital blocks and 12 analog blocks.

### The PSoC Core

The PSoC Core is a powerful engine that supports a rich feature set. The core includes a CPU, memory, clocks, and configurable GPIO (General Purpose IO).

The M8C CPU core is a powerful processor with speeds up to 12 MHz, providing a two MIPS 8-bit Harvard architecture micro-

processor. The CPU utilizes an interrupt controller with 17 vectors, to simplify programming of real time embedded events. Program execution is timed and protected using the included Sleep and Watch Dog Timers (WDT).

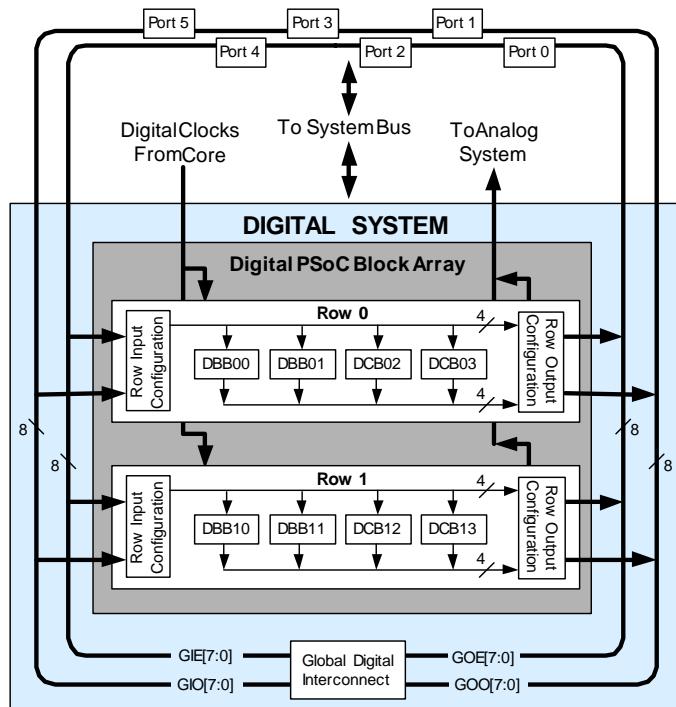
Memory includes 16 KB of Flash for program storage and 256 bytes of SRAM for data storage. Program Flash utilizes four protection levels on blocks of 64 bytes, allowing customized software IP protection.

The PSoC device incorporates flexible internal clock generators, including a 24 MHz IMO (internal main oscillator) accurate to 4% over temperature and voltage. A low power 32 kHz ILO (internal low speed oscillator) is provided for the Sleep timer and WDT. If crystal accuracy is desired, the ECO (32.768 kHz external crystal oscillator) is available for use as a Real Time Clock (RTC) and can optionally generate a crystal-accurate 24 MHz system clock using a PLL. The clocks, together with programmable clock dividers (as a System Resource), provide the flexibility to integrate almost any timing requirement into the PSoC device.

PSoC GPIOs provide connection to the CPU, digital and analog resources of the device. Each pin's drive mode may be selected from eight options, allowing great flexibility in external interfacing. Every pin also has the capability to generate a system interrupt on high level, low level, and change from last read.

## The Digital System

The Digital System is composed of 8 digital PSoC blocks. Each block is an 8-bit resource that can be used alone or combined with other blocks to form 8, 16, 24, and 32-bit peripherals, which are called user module references.



Digital System Block Diagram

Digital peripheral configurations include those listed below.

- PWMs (8 to 32 bit)
- PWMs with Dead Band (8 to 32 bit)
- Counters (8 to 32 bit)
- Timers (8 to 32 bit)
- UART 8 bit with selectable parity (up to 2)
- SPI Master and Slave (up to 2)
- I2C Slave and Multi-master (1 available as a System Resource)
- Cyclical Redundancy Checker/Generator (8 to 32 bit)
- IrDA (up to 2)
- Pseudo Random Sequence Generators (8 to 32 bit)

The digital blocks can be connected to any GPIO through a series of global buses that can route any signal to any pin. The buses also allow for signal multiplexing and for performing logic operations. This configurability frees your designs from the constraints of a fixed peripheral controller.

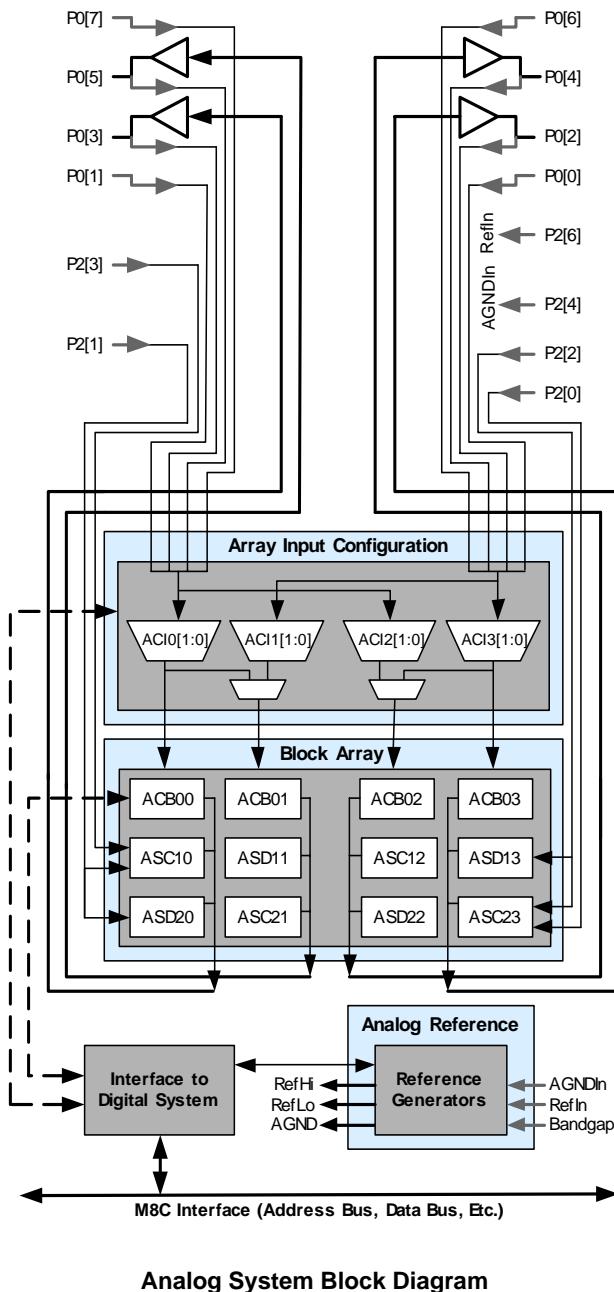
Digital blocks are provided in rows of four, where the number of blocks varies by PSoC device family. This allows you the optimum choice of system resources for your application. Family resources are shown in the table titled "[PSoC Device Characteristics](#)" on page 3.

## The Analog System

The Analog System is composed of 12 configurable blocks, each comprised of an opamp circuit allowing the creation of complex analog signal flows. Analog peripherals are very flexible and can be customized to support specific application requirements. Some of the more common PSoC analog functions (most available as user modules) are listed below.

- Analog-to-digital converters (up to 4, with 6- to 14-bit resolution, selectable as Incremental, Delta Sigma, and SAR)
- Filters (2, 4, 6, and 8 pole band-pass, low-pass, and notch)
- Amplifiers (up to 4, with selectable gain to 48x)
- Instrumentation amplifiers (up to 2, with selectable gain to 93x)
- Comparators (up to 4, with 16 selectable thresholds)
- DACs (up to 4, with 6- to 9-bit resolution)
- Multiplying DACs (up to 4, with 6- to 9-bit resolution)
- High current output drivers (four with 40 mA drive as a PSoC Core resource)
- 1.3V reference (as a System Resource)
- DTMF Dialer
- Modulators
- Correlators
- Peak Detectors
- Many other topologies possible

Analog blocks are provided in columns of three, which include one CT (Continuous Time) and two SC (Switched Capacitor) blocks, as shown in the figure below.



## Additional System Resources

System Resources, some of which have been previously listed, provide additional capability useful to complete systems. Additional resources include a multiplier, decimator, switch mode pump, low voltage detection, and power on reset. Brief statements describing the merits of each system resource are presented below.

- Digital clock dividers provide three customizable clock frequencies for use in applications. The clocks can be routed to both the digital and analog systems. Additional clocks can be generated using digital PSoC blocks as clock dividers.
- A multiply accumulate (MAC) provides a fast 8-bit multiplier with 32-bit accumulate to assist in both general math as well as digital filters.
- The decimator provides a custom hardware filter for digital signal processing applications including the creation of Delta Sigma ADCs.
- The I2C module provides 100 and 400 kHz communication over two wires. Slave, master, and multi-master modes are all supported.
- Low Voltage Detection (LVD) interrupts can signal the application of falling voltage levels, while the advanced POR (Power On Reset) circuit eliminates the need for a system supervisor.
- An internal 1.3V reference provides an absolute reference for the analog system, including ADCs and DACs.

## PSoC Device Characteristics

Depending on your PSoC device characteristics, the digital and analog systems can have 16, 8, or 4 digital blocks and 12, 6, or 4 analog blocks. The following table lists the resources available for specific PSoC device groups. The PSoC device covered by this data sheet is highlighted below.

### PSoC Device Characteristics

| PSoC Part Number | Digital IO      | Digital Rows | Digital Blocks | Analog Inputs | Analog Outputs | Analog Columns | Analog Blocks  | SRAM Size        | Flash Size |
|------------------|-----------------|--------------|----------------|---------------|----------------|----------------|----------------|------------------|------------|
| CY8C29x66        | up to 64        | 4            | 16             | 12            | 4              | 4              | 12             | 2K               | 32K        |
| <b>CY8C27x43</b> | <b>up to 44</b> | <b>2</b>     | <b>8</b>       | <b>12</b>     | <b>4</b>       | <b>4</b>       | <b>12</b>      | <b>256 Bytes</b> | <b>16K</b> |
| CY8C24x94        | 56              | 1            | 4              | 48            | 2              | 2              | 6              | 1K               | 16K        |
| CY8C24x23A       | up to 24        | 1            | 4              | 12            | 2              | 2              | 6              | 256 Bytes        | 4K         |
| CY8C21x34        | up to 28        | 1            | 4              | 28            | 0              | 2              | 4 <sup>a</sup> | 512 Bytes        | 8K         |
| CY8C21x23        | 16              | 1            | 4              | 8             | 0              | 2              | 4 <sup>a</sup> | 256 Bytes        | 4K         |
| CY8C20x34        | up to 28        | 0            | 0              | 28            | 0              | 0              | 3 <sup>b</sup> | 512 Bytes        | 8K         |

a. Limited analog functionality.

b. Two analog blocks and one CapSense.

## Getting Started

The quickest path to understanding the PSoC silicon is by reading this data sheet and using the PSoC Designer Integrated Development Environment (IDE). This data sheet is an overview of the PSoC integrated circuit and presents specific pin, register, and electrical specifications. For in-depth information, along with detailed programming information, reference the *PSoC Mixed-Signal Array Technical Reference Manual*.

For up-to-date Ordering, Packaging, and Electrical Specification information, reference the latest PSoC device data sheets on the web at <http://www.cypress.com/psoc>.

## Development Kits

Development Kits are available from the following distributors: Digi-Key, Avnet, Arrow, and Future. The Cypress Online Store contains development kits, C compilers, and all accessories for PSoC development. Go to the Cypress Online Store web site at <http://www.cypress.com>, click the Online Store shopping cart icon at the bottom of the web page, and click *PSoC (Programmable System-on-Chip)* to view a current list of available items.

## Technical Training Modules

Free PSoC technical training modules are available for users new to PSoC. Training modules cover designing, debugging, advanced analog and CapSense. Go to <http://www.cypress.com/techtrain>.

## Consultants

Certified PSoC Consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC Consultant go to <http://www.cypress.com>, click on Design Support located on the left side of the web page, and select CYPros Consultants.

## Technical Support

PSoC application engineers take pride in fast and accurate response. They can be reached with a 4-hour guaranteed response at <http://www.cypress.com/support/login.cfm>.

## Application Notes

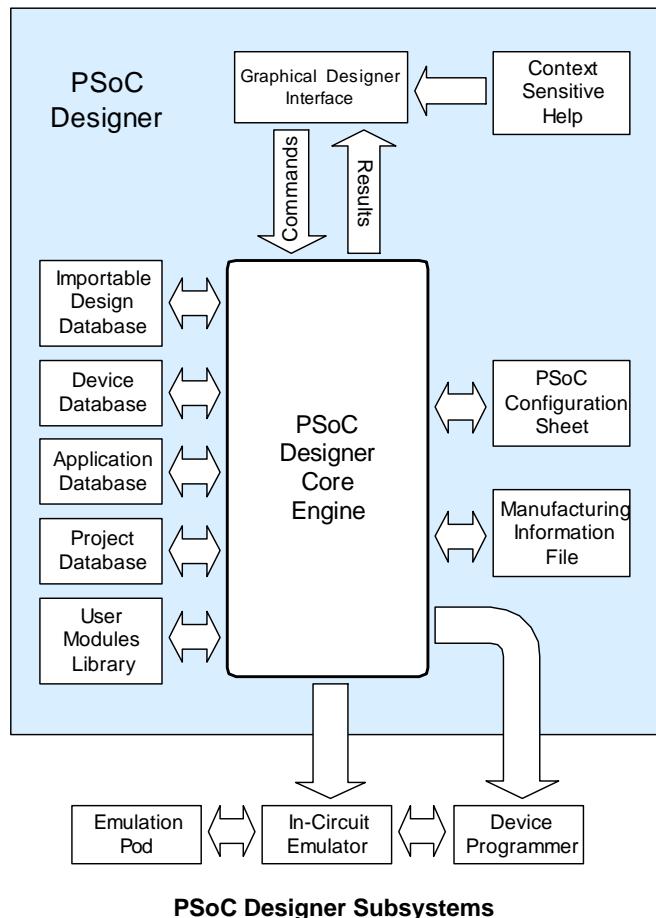
A long list of application notes will assist you in every aspect of your design effort. To view the PSoC application notes, go to the <http://www.cypress.com> web site and select Application Notes under the Design Resources list located in the center of the web page. Application notes are listed by date by default.

## Development Tools

PSoC Designer is a Microsoft® Windows-based, integrated development environment for the Programmable System-on-Chip (PSoC) devices. The PSoC Designer IDE and application runs on Windows NT 4.0, Windows 2000, Windows Millennium (Me), or Windows XP. (Reference the PSoC Designer Functional Flow diagram below.)

PSoC Designer helps the customer to select an operating configuration for the PSoC, write application code that uses the PSoC, and debug the application. This system provides design database management by project, an integrated debugger with In-Circuit Emulator, in-system programming support, and the macro assembler for the CPUs.

PSoC Designer also supports a high-level C language compiler developed specifically for the devices in the family.



## PSoC Designer Software Subsystems

### *Device Editor*

The Device Editor subsystem allows the user to select different onboard analog and digital components called user modules using the PSoC blocks. Examples of user modules are ADCs, DACs, Amplifiers, and Filters.

The device editor also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic configuration allows for changing configurations at run time.

PSoC Designer sets up power-on initialization tables for selected PSoC block configurations and creates source code for an application framework. The framework contains software to operate the selected components and, if the project uses more than one operating configuration, contains routines to switch between different sets of PSoC block configurations at run time. PSoC Designer can print out a configuration sheet for given project configuration for use during application programming in conjunction with the Device Data Sheet. Once the framework is generated, the user can add application-specific code to flesh out the framework. It's also possible to change the selected components and regenerate the framework.

### *Design Browser*

The Design Browser allows users to select and import preconfigured designs into the user's project. Users can easily browse a catalog of preconfigured designs to facilitate time-to-design. Examples provided in the tools include a 300-baud modem, LIN Bus master and slave, fan controller, and magnetic card reader.

### *Application Editor*

In the Application Editor you can edit your C language and Assembly language source code. You can also assemble, compile, link, and build.

**Assembler.** The macro assembler allows the assembly code to be merged seamlessly with C code. The link libraries automatically use absolute addressing or can be compiled in relative mode, and linked with other software modules to get absolute addressing.

**C Language Compiler.** A C language compiler is available that supports Cypress MicroSystems' PSoC family devices. Even if you have never worked in the C language before, the product quickly allows you to create complete C programs for the PSoC family devices.

The embedded, optimizing C compiler provides all the features of C tailored to the PSoC architecture. It comes complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

### *Debugger*

The PSoC Designer Debugger subsystem provides hardware in-circuit emulation, allowing the designer to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow the designer to read and program and read and write data memory, read and write IO registers, read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also allows the designer to create a trace buffer of registers and memory locations of interest.

### *Online Help System*

The online help system displays online, context-sensitive help for the user. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an Online Support Forum to aid the designer in getting started.

## Hardware Tools

### *In-Circuit Emulator*

A low cost, high functionality ICE (In-Circuit Emulator) is available for development support. This hardware has the capability to program single devices.

The emulator consists of a base unit that connects to the PC by way of the parallel or USB port. The base unit is universal and will operate with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full speed (24 MHz) operation.

## Designing with User Modules

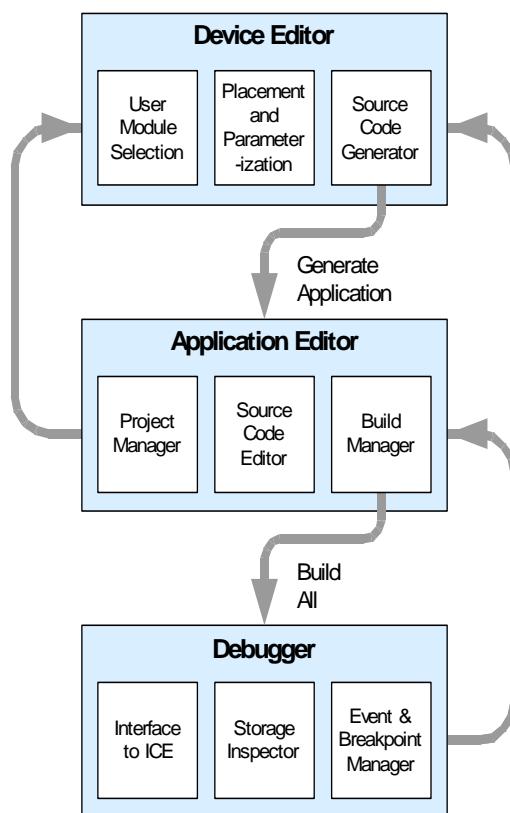
The development process for the PSoC device differs from that of a traditional fixed function microprocessor. The configurable analog and digital hardware blocks give the PSoC architecture a unique flexibility that pays dividends in managing specification change during development and later by lowering inventory costs. These configurable resources, called PSoC Blocks, have the ability to implement a wide variety of user-selectable functions. Each block has several registers that determine its function and connectivity to other blocks, multiplexers, buses and to the IO pins. Iterative development cycles permit you to adapt the hardware as well as the software. This substantially lowers the risk that you will have to select a different part to meet the final design requirements.

To speed the development process, the PSoC Designer Integrated Development Environment (IDE) provides a library of pre-built, pre-tested hardware peripheral functions, called "User Modules." User modules make selecting and implementing peripheral devices simple, and come in analog, digital, and mixed signal varieties. The standard User Module library contains over 50 common peripherals such as ADCs, DACs Timers, Counters, UARTs, and other not-so common peripherals such as DTMF Generators and Bi-Quad analog filter sections.

Each user module establishes the basic register settings that implement the selected function. It also provides parameters that allow you to tailor its precise configuration to your particular application. For example, a Pulse Width Modulator User Module configures one or more digital PSoC blocks, one for each 8 bits of resolution. The user module parameters permit you to establish the pulse width and duty cycle. User modules also provide tested software to cut your development time. The user module application programming interface (API) provides high-level functions to control and respond to hardware events at run-time. The API also provides optional interrupt service routines that you can adapt as needed.

The API functions are documented in user module data sheets that are viewed directly in the PSoC Designer IDE. These data sheets explain the internal operation of the user module and provide performance specifications. Each data sheet describes the use of each user module parameter and documents the setting of each register controlled by the user module.

The development process starts when you open a new project and bring up the Device Editor, a graphical user interface (GUI) for configuring the hardware. You pick the user modules you need for your project and map them onto the PSoC blocks with point-and-click simplicity. Next, you build signal chains by interconnecting user modules to each other and the IO pins. At this stage, you also configure the clock source connections and enter parameter values directly or by selecting values from drop-down menus. When you are ready to test the hardware configuration or move on to developing code for the project, you perform the "Generate Application" step. This causes PSoC Designer to generate source code that automatically configures the device to your specification and provides the high-level user module API functions.



### User Module and Source Code Development Flows

The next step is to write your main program, and any sub-routines using PSoC Designer's Application Editor subsystem. The Application Editor includes a Project Manager that allows you to open the project source code files (including all generated code files) from a hierarchical view. The source code editor provides syntax coloring and advanced edit features for both C and assembly language. File search capabilities include simple string searches and recursive "grep-style" patterns. A single mouse click invokes the Build Manager. It employs a professional-strength "makefile" system to automatically analyze all file dependencies and run the compiler and assembler as necessary. Project-level options control optimization strategies used by the compiler and linker. Syntax errors are displayed in a console window. Double clicking the error message takes you directly to the offending line of source code. When all is correct, the linker builds a HEX file image suitable for programming.

The last step in the development process takes place inside the PSoC Designer's Debugger subsystem. The Debugger downloads the HEX image to the In-Circuit Emulator (ICE) where it runs at full speed. Debugger capabilities rival those of systems costing many times more. In addition to traditional single-step, run-to-breakpoint and watch-variable features, the Debugger provides a large trace buffer and allows you define complex breakpoint events that include monitoring address and data bus values, memory locations and external signals.

## Document Conventions

### Acronyms Used

The following table lists the acronyms that are used in this document.

| Acronym | Description   |
|---------|---|
| AC      | alternating current                                 |
| ADC     | analog-to-digital converter                         |
| API     | application programming interface                   |
| CPU     | central processing unit                             |
| CT      | continuous time                                     |
| DAC     | digital-to-analog converter                         |
| DC      | direct current                                      |
| ECO     | external crystal oscillator                         |
| EEPROM  | electrically erasable programmable read-only memory |
| FSR     | full scale range                                    |
| GPIO    | general purpose IO                                  |
| GUI     | graphical user interface                            |
| HBM     | human body model                                    |
| ICE     | in-circuit emulator                                 |
| ILO     | internal low speed oscillator                       |
| IMO     | internal main oscillator                            |
| IO      | input/output  |
| IPOR    | imprecise power on reset                            |
| Lsb     | least-significant bit                               |
| LVD     | low voltage detect                                  |
| MSb     | most-significant bit                                |
| PC      | program counter                                     |
| PLL     | phase-locked loop                                   |
| POR     | power on reset                                      |
| PPOR    | precision power on reset                            |
| PSoC®   | Programmable System-on-Chip™                        |
| PWM     | pulse width modulator                               |
| SC      | switched capacitor                                  |
| SRAM    | static random access memory                         |

### Units of Measure

A units of measure table is located in the Electrical Specifications section. [Table 3-1 on page 14](#) lists all the abbreviations used to measure the PSoC devices.

### Numeric Naming

Hexadecimal numbers are represented with all letters in uppercase with an appended lowercase 'h' (for example, '14h' or '3Ah'). Hexadecimal numbers may also be represented by a '0x' prefix, the C coding convention. Binary numbers have an appended lowercase 'b' (e.g., 01010100b' or '01000011b'). Numbers not indicated by an 'h' or 'b' are decimal.

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# 1. Pin Information



This chapter describes, lists, and illustrates the CY8C27x43 automotive PSoC device pins and pinout configurations.

## 1.1 Pinouts

The CY8C27x43 automotive PSoC device is available in a variety of packages which are listed and illustrated in the following tables. Every port pin (labeled with a "P") is capable of Digital IO. However, Vss, Vdd, and XRES are not capable of Digital IO.

### 1.1.1 20-Pin Part Pinout

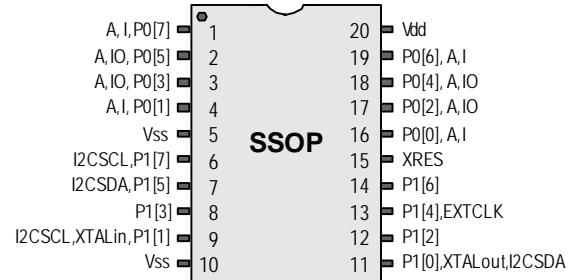
**Table 1-1. 20-Pin Part Pinout (SSOP)**

| Pin No. | Type    |        | Pin Name | Description   |
|---------|---------|--------|----------|---|
|         | Digital | Analog |          |   |
| 1       | IO      | I      | P0[7]    | Analog column mux input.                                      |
| 2       | IO      | IO     | P0[5]    | Analog column mux input and column output.                    |
| 3       | IO      | IO     | P0[3]    | Analog column mux input and column output.                    |
| 4       | IO      | I      | P0[1]    | Analog column mux input.                                      |
| 5       | Power   |        | Vss      | Ground connection.  |
| 6       | IO      |        | P1[7]    | I2C Serial Clock (SCL).                                       |
| 7       | IO      |        | P1[5]    | I2C Serial Data (SDA).  |
| 8       | IO      |        | P1[3]    |   |
| 9       | IO      |        | P1[1]    | Crystal Input (XTALin), I2C Serial Clock (SCL), ISSP-SCLK*.   |
| 10      | Power   |        | Vss      | Ground connection.  |
| 11      | IO      |        | P1[0]    | Crystal Output (XTALout), I2C Serial Data (SDA), ISSP-SDATA*. |
| 12      | IO      |        | P1[2]    |   |
| 13      | IO      |        | P1[4]    | Optional External Clock Input (EXTCLK).                       |
| 14      | IO      |        | P1[6]    |   |
| 15      | Input   |        | XRES     | Active high external reset with internal pull down.           |
| 16      | IO      | I      | P0[0]    | Analog column mux input.                                      |
| 17      | IO      | IO     | P0[2]    | Analog column mux input and column output.                    |
| 18      | IO      | IO     | P0[4]    | Analog column mux input and column output.                    |
| 19      | IO      | I      | P0[6]    | Analog column mux input.                                      |
| 20      | Power   |        | Vdd      | Supply voltage.   |

**LEGEND:** A = Analog, I = Input, and O = Output.

\* These are the ISSP pins, which are not High Z at POR (Power On Reset). See the *PSoC Mixed-Signal Array Technical Reference Manual* for details.

**CY8C27243 20-Pin PSoC Device**



## 1.1.2 28-Pin Part Pinout

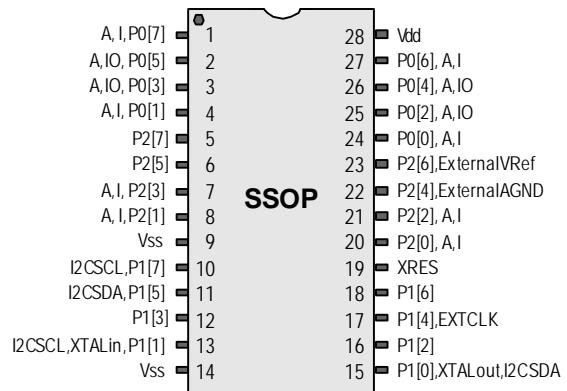
**Table 1-2. 28-Pin Part Pinout (SSOP)**

| Pin No. | Type    |        | Pin Name | Description   |
|---------|---------|--------|----------|---|
|         | Digital | Analog |          |   |
| 1       | IO      | I      | P0[7]    | Analog column mux input.                                      |
| 2       | IO      | IO     | P0[5]    | Analog column mux input and column output.                    |
| 3       | IO      | IO     | P0[3]    | Analog column mux input and column output.                    |
| 4       | IO      | I      | P0[1]    | Analog column mux input.                                      |
| 5       | IO      |        | P2[7]    |   |
| 6       | IO      |        | P2[5]    |   |
| 7       | IO      | I      | P2[3]    | Direct switched capacitor block input.                        |
| 8       | IO      | I      | P2[1]    | Direct switched capacitor block input.                        |
| 9       | Power   |        | Vss      | Ground connection.  |
| 10      | IO      |        | P1[7]    | I2C Serial Clock (SCL).                                       |
| 11      | IO      |        | P1[5]    | I2C Serial Data (SDA).  |
| 12      | IO      |        | P1[3]    |   |
| 13      | IO      |        | P1[1]    | Crystal Input (XTALin), I2C Serial Clock (SCL), ISSP-SCLK*.   |
| 14      | Power   |        | Vss      | Ground connection.  |
| 15      | IO      |        | P1[0]    | Crystal Output (XTALout), I2C Serial Data (SDA), ISSP-SDATA*. |
| 16      | IO      |        | P1[2]    |   |
| 17      | IO      |        | P1[4]    | Optional External Clock Input (EXTCLK).                       |
| 18      | IO      |        | P1[6]    |   |
| 19      | Input   |        | XRES     | Active high external reset with internal pull down.           |
| 20      | IO      | I      | P2[0]    | Direct switched capacitor block input.                        |
| 21      | IO      | I      | P2[2]    | Direct switched capacitor block input.                        |
| 22      | IO      |        | P2[4]    | External Analog Ground (AGND).                                |
| 23      | IO      |        | P2[6]    | External Voltage Reference (VRef).                            |
| 24      | IO      | I      | P0[0]    | Analog column mux input.                                      |
| 25      | IO      | IO     | P0[2]    | Analog column mux input and column output.                    |
| 26      | IO      | IO     | P0[4]    | Analog column mux input and column output.                    |
| 27      | IO      | I      | P0[6]    | Analog column mux input.                                      |
| 28      | Power   |        | Vdd      | Supply voltage.   |

**LEGEND:** A = Analog, I = Input, and O = Output.

\* These are the ISSP pins, which are not High Z at POR (Power On Reset). See the *PSoC Mixed-Signal Array Technical Reference Manual* for details.

**CY8C27443 28-Pin PSoC Device**



### 1.1.3 48-Pin Part Pinout

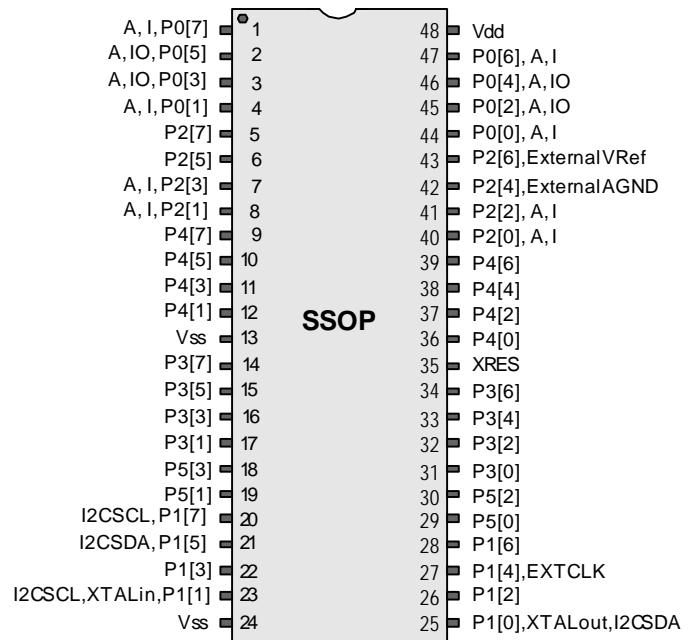
Table 1-3. 48-Pin Part Pinout (SSOP)

| Pin No. | Type    |        | Pin Name | Description   |
|---------|---------|--------|----------|---|
|         | Digital | Analog |          |   |
| 1       | IO      | I      | P0[7]    | Analog column mux input.                                      |
| 2       | IO      | IO     | P0[5]    | Analog column mux input and column output.                    |
| 3       | IO      | IO     | P0[3]    | Analog column mux input and column output.                    |
| 4       | IO      | I      | P0[1]    | Analog column mux input.                                      |
| 5       | IO      |        | P2[7]    |   |
| 6       | IO      |        | P2[5]    |   |
| 7       | IO      | I      | P2[3]    | Direct switched capacitor block input.                        |
| 8       | IO      | I      | P2[1]    | Direct switched capacitor block input.                        |
| 9       | IO      |        | P4[7]    |   |
| 10      | IO      |        | P4[5]    |   |
| 11      | IO      |        | P4[3]    |   |
| 12      | IO      |        | P4[1]    |   |
| 13      | Power   |        | Vss      | Ground connection.  |
| 14      | IO      |        | P3[7]    |   |
| 15      | IO      |        | P3[5]    |   |
| 16      | IO      |        | P3[3]    |   |
| 17      | IO      |        | P3[1]    |   |
| 18      | IO      |        | P5[3]    |   |
| 19      | IO      |        | P5[1]    |   |
| 20      | IO      |        | P1[7]    | I2C Serial Clock (SCL).                                       |
| 21      | IO      |        | P1[5]    | I2C Serial Data (SDA).  |
| 22      | IO      |        | P1[3]    |   |
| 23      | IO      |        | P1[1]    | Crystal Input (XTALin), I2C Serial Clock (SCL), ISSP-SCLK*.   |
| 24      | Power   |        | Vss      | Ground connection.  |
| 25      | IO      |        | P1[0]    | Crystal Output (XTALout), I2C Serial Data (SDA), ISSP-SDATA*. |
| 26      | IO      |        | P1[2]    |   |
| 27      | IO      |        | P1[4]    | Optional External Clock Input (EXTCLK).                       |
| 28      | IO      |        | P1[6]    |   |
| 29      | IO      |        | P5[0]    |   |
| 30      | IO      |        | P5[2]    |   |
| 31      | IO      |        | P3[0]    |   |
| 32      | IO      |        | P3[2]    |   |
| 33      | IO      |        | P3[4]    |   |
| 34      | IO      |        | P3[6]    |   |
| 35      | Input   |        | XRES     | Active high external reset with internal pull down.           |
| 36      | IO      |        | P4[0]    |   |
| 37      | IO      |        | P4[2]    |   |
| 38      | IO      |        | P4[4]    |   |
| 39      | IO      |        | P4[6]    |   |
| 40      | IO      | I      | P2[0]    | Direct switched capacitor block input.                        |
| 41      | IO      | I      | P2[2]    | Direct switched capacitor block input.                        |
| 42      | IO      |        | P2[4]    | External Analog Ground (AGND).                                |
| 43      | IO      |        | P2[6]    | External Voltage Reference (VRef).                            |
| 44      | IO      | I      | P0[0]    | Analog column mux input.                                      |
| 45      | IO      | IO     | P0[2]    | Analog column mux input and column output.                    |
| 46      | IO      | IO     | P0[4]    | Analog column mux input and column output.                    |
| 47      | IO      | I      | P0[6]    | Analog column mux input.                                      |
| 48      | Power   |        | Vdd      | Supply voltage.   |

LEGEND: A = Analog, I = Input, and O = Output.

\* These are the ISSP pins, which are not High Z at POR (Power On Reset). See the *PSoC Mixed-Signal Array Technical Reference Manual* for details.

CY8C27643 48-Pin PSoC Device



## 2. Register Reference



This chapter lists the registers of the CY8C27x43 automotive PSoC devices. For detailed register information, reference the *PSoC Mixed-Signal Array Technical Reference Manual*.

### 2.1 Register Conventions

The register conventions specific to this section are listed in the following table.

| Convention | Description                  |
|------------|------------------------------|
| R          | Read register or bit(s)      |
| W          | Write register or bit(s)     |
| L          | Logical register or bit(s)   |
| C          | Clearable register or bit(s) |
| #          | Access is bit specific       |

### 2.2 Register Mapping Tables

The PSoC device has a total register address space of 512 bytes. The register space is referred to as IO space and is divided into two banks. The XOI bit in the Flag register (CPU\_F) determines which bank the user is currently in. When the XOI bit is set the user is in Bank 1.

**Note** In the following register mapping tables, blank fields are Reserved and should not be accessed.

## Register Map Bank 0 Table: User Space

| Name     | Addr<br>(0,Hex) | Access |
|----------|-----------------|--------|----------|-----------------|--------|----------|-----------------|--------|----------|-----------------|--------|
| PRT0DR   | 00              | RW     |          | 40              |        | ASC10CR0 | 80              | RW     |          | C0              |        |
| PRT0IE   | 01              | RW     |          | 41              |        | ASC10CR1 | 81              | RW     |          | C1              |        |
| PRT0GS   | 02              | RW     |          | 42              |        | ASC10CR2 | 82              | RW     |          | C2              |        |
| PRT0DM2  | 03              | RW     |          | 43              |        | ASC10CR3 | 83              | RW     |          | C3              |        |
| PRT1DR   | 04              | RW     |          | 44              |        | ASD11CR0 | 84              | RW     |          | C4              |        |
| PRT1IE   | 05              | RW     |          | 45              |        | ASD11CR1 | 85              | RW     |          | C5              |        |
| PRT1GS   | 06              | RW     |          | 46              |        | ASD11CR2 | 86              | RW     |          | C6              |        |
| PRT1DM2  | 07              | RW     |          | 47              |        | ASD11CR3 | 87              | RW     |          | C7              |        |
| PRT2DR   | 08              | RW     |          | 48              |        | ASC12CR0 | 88              | RW     |          | C8              |        |
| PRT2IE   | 09              | RW     |          | 49              |        | ASC12CR1 | 89              | RW     |          | C9              |        |
| PRT2GS   | 0A              | RW     |          | 4A              |        | ASC12CR2 | 8A              | RW     |          | CA              |        |
| PRT2DM2  | 0B              | RW     |          | 4B              |        | ASC12CR3 | 8B              | RW     |          | CB              |        |
| PRT3DR   | 0C              | RW     |          | 4C              |        | ASD13CR0 | 8C              | RW     |          | CC              |        |
| PRT3IE   | 0D              | RW     |          | 4D              |        | ASD13CR1 | 8D              | RW     |          | CD              |        |
| PRT3GS   | 0E              | RW     |          | 4E              |        | ASD13CR2 | 8E              | RW     |          | CE              |        |
| PRT3DM2  | 0F              | RW     |          | 4F              |        | ASD13CR3 | 8F              | RW     |          | CF              |        |
| PRT4DR   | 10              | RW     |          | 50              |        | ASD20CR0 | 90              | RW     |          | D0              |        |
| PRT4IE   | 11              | RW     |          | 51              |        | ASD20CR1 | 91              | RW     |          | D1              |        |
| PRT4GS   | 12              | RW     |          | 52              |        | ASD20CR2 | 92              | RW     |          | D2              |        |
| PRT4DM2  | 13              | RW     |          | 53              |        | ASD20CR3 | 93              | RW     |          | D3              |        |
| PRT5DR   | 14              | RW     |          | 54              |        | ASC21CR0 | 94              | RW     |          | D4              |        |
| PRT5IE   | 15              | RW     |          | 55              |        | ASC21CR1 | 95              | RW     |          | D5              |        |
| PRT5GS   | 16              | RW     |          | 56              |        | ASC21CR2 | 96              | RW     | I2C_CFG  | D6              | RW     |
| PRT5DM2  | 17              | RW     |          | 57              |        | ASC21CR3 | 97              | RW     | I2C_SCR  | D7              | #      |
|          | 18              |        |          | 58              |        | ASD22CR0 | 98              | RW     | I2C_DR   | D8              | RW     |
|          | 19              |        |          | 59              |        | ASD22CR1 | 99              | RW     | I2C_MSCR | D9              | #      |
|          | 1A              |        |          | 5A              |        | ASD22CR2 | 9A              | RW     | INT_CLR0 | DA              | RW     |
|          | 1B              |        |          | 5B              |        | ASD22CR3 | 9B              | RW     | INT_CLR1 | DB              | RW     |
|          | 1C              |        |          | 5C              |        | ASC23CR0 | 9C              | RW     |          | DC              |        |
|          | 1D              |        |          | 5D              |        | ASC23CR1 | 9D              | RW     | INT_CLR3 | DD              | RW     |
|          | 1E              |        |          | 5E              |        | ASC23CR2 | 9E              | RW     | INT_MSK3 | DE              | RW     |
|          | 1F              |        |          | 5F              |        | ASC23CR3 | 9F              | RW     |          | DF              |        |
| DBB00DR0 | 20              | #      | AMX_IN   | 60              | RW     |          | A0              |        | INT_MSK0 | E0              | RW     |
| DBB00DR1 | 21              | W      |          | 61              |        |          | A1              |        | INT_MSK1 | E1              | RW     |
| DBB00DR2 | 22              | RW     |          | 62              |        |          | A2              |        | INT_VC   | E2              | RC     |
| DBB00CR0 | 23              | #      | ARF_CR   | 63              | RW     |          | A3              |        | RES_WDT  | E3              | W      |
| DBB01DR0 | 24              | #      | CMP_CR0  | 64              | #      |          | A4              |        | DEC_DH   | E4              | RC     |
| DBB01DR1 | 25              | W      | ASY_CR   | 65              | #      |          | A5              |        | DEC_DL   | E5              | RC     |
| DBB01DR2 | 26              | RW     | CMP_CR1  | 66              | RW     |          | A6              |        | DEC_CR0  | E6              | RW     |
| DBB01CR0 | 27              | #      |          | 67              |        |          | A7              |        | DEC_CR1  | E7              | RW     |
| DCB02DR0 | 28              | #      |          | 68              |        |          | A8              |        | MUL_X    | E8              | W      |
| DCB02DR1 | 29              | W      |          | 69              |        |          | A9              |        | MUL_Y    | E9              | W      |
| DCB02DR2 | 2A              | RW     |          | 6A              |        |          | AA              |        | MUL_DH   | EA              | R      |
| DCB02CR0 | 2B              | #      |          | 6B              |        |          | AB              |        | MUL_DL   | EB              | R      |
| DCB03DR0 | 2C              | #      |          | 6C              |        |          | AC              |        | ACC_DR1  | EC              | RW     |
| DCB03DR1 | 2D              | W      |          | 6D              |        |          | AD              |        | ACC_DR0  | ED              | RW     |
| DCB03DR2 | 2E              | RW     |          | 6E              |        |          | AE              |        | ACC_DR3  | EE              | RW     |
| DCB03CR0 | 2F              | #      |          | 6F              |        |          | AF              |        | ACC_DR2  | EF              | RW     |
| DBB10DR0 | 30              | #      | ACB00CR3 | 70              | RW     | RDI0RI   | B0              | RW     |          | F0              |        |
| DBB10DR1 | 31              | W      | ACB00CR0 | 71              | RW     | RDI0SYN  | B1              | RW     |          | F1              |        |
| DBB10DR2 | 32              | RW     | ACB00CR1 | 72              | RW     | RDI0IS   | B2              | RW     |          | F2              |        |
| DBB10CR0 | 33              | #      | ACB00CR2 | 73              | RW     | RDI0LT0  | B3              | RW     |          | F3              |        |
| DBB11DR0 | 34              | #      | ACB01CR3 | 74              | RW     | RDI0LT1  | B4              | RW     |          | F4              |        |
| DBB11DR1 | 35              | W      | ACB01CR0 | 75              | RW     | RDI0RO0  | B5              | RW     |          | F5              |        |
| DBB11DR2 | 36              | RW     | ACB01CR1 | 76              | RW     | RDI0RO1  | B6              | RW     |          | F6              |        |
| DBB11CR0 | 37              | #      | ACB01CR2 | 77              | RW     |          | B7              |        | CPU_F    | F7              | RL     |
| DCB12DR0 | 38              | #      | ACB02CR3 | 78              | RW     | RDI1RI   | B8              | RW     |          | F8              |        |
| DCB12DR1 | 39              | W      | ACB02CR0 | 79              | RW     | RDI1SYN  | B9              | RW     |          | F9              |        |
| DCB12DR2 | 3A              | RW     | ACB02CR1 | 7A              | RW     | RDI1IS   | BA              | RW     |          | FA              |        |
| DCB12CR0 | 3B              | #      | ACB02CR2 | 7B              | RW     | RDI1LT0  | BB              | RW     |          | FB              |        |
| DCB13DR0 | 3C              | #      | ACB03CR3 | 7C              | RW     | RDI1LT1  | BC              | RW     |          | FC              |        |
| DCB13DR1 | 3D              | W      | ACB03CR0 | 7D              | RW     | RDI1RO0  | BD              | RW     |          | FD              |        |
| DCB13DR2 | 3E              | RW     | ACB03CR1 | 7E              | RW     | RDI1RO1  | BE              | RW     | CPU_SCR1 | FE              | #      |
| DCB13CR0 | 3F              | #      | ACB03CR2 | 7F              | RW     |          | BF              |        | CPU_SCR0 | FF              | #      |

Blank fields are Reserved and should not be accessed. # Access is bit specific.

## Register Map Bank 1 Table: Configuration Space

| Name    | Addr<br>(1,Hex) | Access | Name     | Addr<br>(1,Hex) | Access | Name     | Addr<br>(1,Hex) | Access | Name      | Addr<br>(1,Hex) | Access |
|---------|-----------------|--------|----------|-----------------|--------|----------|-----------------|--------|-----------|-----------------|--------|
| PRT0DM0 | 00              | RW     |          | 40              |        | ASC10CR0 | 80              | RW     |           | C0              |        |
| PRT0DM1 | 01              | RW     |          | 41              |        | ASC10CR1 | 81              | RW     |           | C1              |        |
| PRT0IC0 | 02              | RW     |          | 42              |        | ASC10CR2 | 82              | RW     |           | C2              |        |
| PRT0IC1 | 03              | RW     |          | 43              |        | ASC10CR3 | 83              | RW     |           | C3              |        |
| PRT1DM0 | 04              | RW     |          | 44              |        | ASD11CR0 | 84              | RW     |           | C4              |        |
| PRT1DM1 | 05              | RW     |          | 45              |        | ASD11CR1 | 85              | RW     |           | C5              |        |
| PRT1IC0 | 06              | RW     |          | 46              |        | ASD11CR2 | 86              | RW     |           | C6              |        |
| PRT1IC1 | 07              | RW     |          | 47              |        | ASD11CR3 | 87              | RW     |           | C7              |        |
| PRT2DM0 | 08              | RW     |          | 48              |        | ASC12CR0 | 88              | RW     |           | C8              |        |
| PRT2DM1 | 09              | RW     |          | 49              |        | ASC12CR1 | 89              | RW     |           | C9              |        |
| PRT2IC0 | 0A              | RW     |          | 4A              |        | ASC12CR2 | 8A              | RW     |           | CA              |        |
| PRT2IC1 | 0B              | RW     |          | 4B              |        | ASC12CR3 | 8B              | RW     |           | CB              |        |
| PRT3DM0 | 0C              | RW     |          | 4C              |        | ASD13CR0 | 8C              | RW     |           | CC              |        |
| PRT3DM1 | 0D              | RW     |          | 4D              |        | ASD13CR1 | 8D              | RW     |           | CD              |        |
| PRT3IC0 | 0E              | RW     |          | 4E              |        | ASD13CR2 | 8E              | RW     |           | CE              |        |
| PRT3IC1 | 0F              | RW     |          | 4F              |        | ASD13CR3 | 8F              | RW     |           | CF              |        |
| PRT4DM0 | 10              | RW     |          | 50              |        | ASD20CR0 | 90              | RW     | GDI_O_IN  | D0              | RW     |
| PRT4DM1 | 11              | RW     |          | 51              |        | ASD20CR1 | 91              | RW     | GDI_E_IN  | D1              | RW     |
| PRT4IC0 | 12              | RW     |          | 52              |        | ASD20CR2 | 92              | RW     | GDI_O_OU  | D2              | RW     |
| PRT4IC1 | 13              | RW     |          | 53              |        | ASD20CR3 | 93              | RW     | GDI_E_OU  | D3              | RW     |
| PRT5DM0 | 14              | RW     |          | 54              |        | ASC21CR0 | 94              | RW     |           | D4              |        |
| PRT5DM1 | 15              | RW     |          | 55              |        | ASC21CR1 | 95              | RW     |           | D5              |        |
| PRT5IC0 | 16              | RW     |          | 56              |        | ASC21CR2 | 96              | RW     |           | D6              |        |
| PRT5IC1 | 17              | RW     |          | 57              |        | ASC21CR3 | 97              | RW     |           | D7              |        |
|         | 18              |        |          | 58              |        | ASD22CR0 | 98              | RW     |           | D8              |        |
|         | 19              |        |          | 59              |        | ASD22CR1 | 99              | RW     |           | D9              |        |
|         | 1A              |        |          | 5A              |        | ASD22CR2 | 9A              | RW     |           | DA              |        |
|         | 1B              |        |          | 5B              |        | ASD22CR3 | 9B              | RW     |           | DB              |        |
|         | 1C              |        |          | 5C              |        | ASC23CR0 | 9C              | RW     |           | DC              |        |
|         | 1D              |        |          | 5D              |        | ASC23CR1 | 9D              | RW     | OSC_GO_EN | DD              | RW     |
|         | 1E              |        |          | 5E              |        | ASC23CR2 | 9E              | RW     | OSC_CR4   | DE              | RW     |
|         | 1F              |        |          | 5F              |        | ASC23CR3 | 9F              | RW     | OSC_CR3   | DF              | RW     |
| DBB00FN | 20              | RW     | CLK_CR0  | 60              | RW     |          | A0              |        | OSC_CR0   | E0              | RW     |
| DBB00IN | 21              | RW     | CLK_CR1  | 61              | RW     |          | A1              |        | OSC_CR1   | E1              | RW     |
| DBB00OU | 22              | RW     | ABF_CR0  | 62              | RW     |          | A2              |        | OSC_CR2   | E2              | RW     |
|         | 23              |        | AMD_CR0  | 63              | RW     |          | A3              |        | VLT_CR    | E3              | RW     |
| DBB01FN | 24              | RW     |          | 64              |        |          | A4              |        | VLT_CMP   | E4              | R      |
| DBB01IN | 25              | RW     |          | 65              |        |          | A5              |        |           | E5              |        |
| DBB01OU | 26              | RW     | AMD_CR1  | 66              | RW     |          | A6              |        |           | E6              |        |
|         | 27              |        | ALT_CR0  | 67              | RW     |          | A7              |        |           | E7              |        |
| DCB02FN | 28              | RW     | ALT_CR1  | 68              | RW     |          | A8              |        | IMO_TR    | E8              | W      |
| DCB02IN | 29              | RW     | CLK_CR2  | 69              | RW     |          | A9              |        | ILO_TR    | E9              | W      |
| DCB02OU | 2A              | RW     |          | 6A              |        |          | AA              |        | BDG_TR    | EA              | RW     |
|         | 2B              |        |          | 6B              |        |          | AB              |        | ECO_TR    | EB              | W      |
| DCB03FN | 2C              | RW     |          | 6C              |        |          | AC              |        |           | EC              |        |
| DCB03IN | 2D              | RW     |          | 6D              |        |          | AD              |        |           | ED              |        |
| DCB03OU | 2E              | RW     |          | 6E              |        |          | AE              |        |           | EE              |        |
|         | 2F              |        |          | 6F              |        |          | AF              |        |           | EF              |        |
| DBB10FN | 30              | RW     | ACB00CR3 | 70              | RW     | RDI0RI   | B0              | RW     |           | F0              |        |
| DBB10IN | 31              | RW     | ACB00CR0 | 71              | RW     | RDI0SYN  | B1              | RW     |           | F1              |        |
| DBB10OU | 32              | RW     | ACB00CR1 | 72              | RW     | RDI0IS   | B2              | RW     |           | F2              |        |
|         | 33              |        | ACB00CR2 | 73              | RW     | RDI0LT0  | B3              | RW     |           | F3              |        |
| DBB11FN | 34              | RW     | ACB01CR3 | 74              | RW     | RDI0LT1  | B4              | RW     |           | F4              |        |
| DBB11IN | 35              | RW     | ACB01CR0 | 75              | RW     | RDI0RO0  | B5              | RW     |           | F5              |        |
| DBB11OU | 36              | RW     | ACB01CR1 | 76              | RW     | RDI0RO1  | B6              | RW     |           | F6              |        |
|         | 37              |        | ACB01CR2 | 77              | RW     |          | B7              |        | CPU_F     | F7              | RL     |
| DCB12FN | 38              | RW     | ACB02CR3 | 78              | RW     | RDI1RI   | B8              | RW     |           | F8              |        |
| DCB12IN | 39              | RW     | ACB02CR0 | 79              | RW     | RDI1SYN  | B9              | RW     |           | F9              |        |
| DCB12OU | 3A              | RW     | ACB02CR1 | 7A              | RW     | RDI1IS   | BA              | RW     |           | FA              |        |
|         | 3B              |        | ACB02CR2 | 7B              | RW     | RDI1LT0  | BB              | RW     |           | FB              |        |
| DCB13FN | 3C              | RW     | ACB03CR3 | 7C              | RW     | RDI1LT1  | BC              | RW     |           | FC              |        |
| DCB13IN | 3D              | RW     | ACB03CR0 | 7D              | RW     | RDI1RO0  | BD              | RW     |           | FD              |        |
| DCB13OU | 3E              | RW     | ACB03CR1 | 7E              | RW     | RDI1RO1  | BE              | RW     | CPU_SCR1  | FE              | #      |
|         | 3F              |        | ACB03CR2 | 7F              | RW     |          | BF              |        | CPU_SCR0  | FF              | #      |

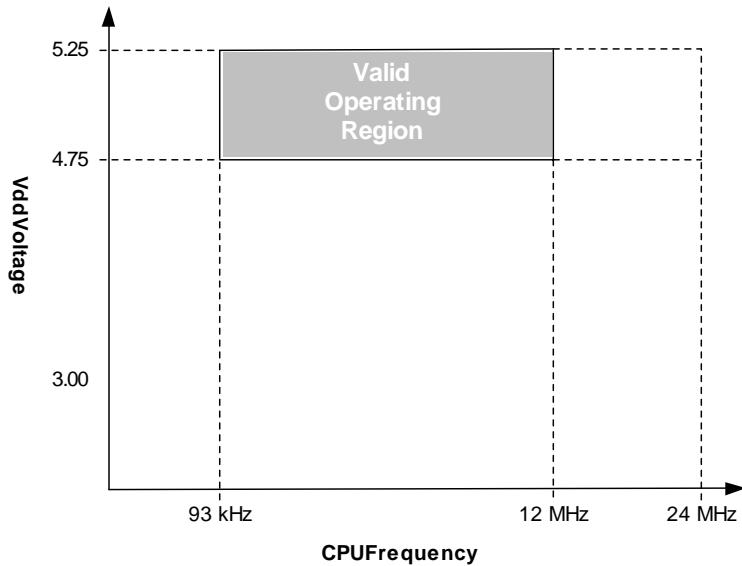
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### 3. Electrical Specifications



This chapter presents the DC and AC electrical specifications of the CY8C27x43 automotive PSoC device. For the most up to date electrical specifications, confirm that you have the most recent data sheet by going to the web at <http://www.cypress.com/psoc>.

Specifications are valid for  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$  and  $T_J \leq 125^{\circ}\text{C}$ , except where noted.



**Figure 3-1. Voltage versus CPU Frequency**

The following table lists the units of measure that are used in this chapter.

**Table 3-1: Units of Measure**

| Symbol                     | Unit of Measure             | Symbol        | Unit of Measure               |
|----------------------------|-----------------------------|---------------|-------------------------------|
| $^{\circ}\text{C}$         | degree Celsius              | $\mu\text{W}$ | microwatts                    |
| dB                         | decibels                    | mA            | milli-ampere                  |
| fF                         | femto farad                 | ms            | milli-second                  |
| Hz                         | hertz                       | mV            | milli-volts                   |
| KB                         | 1024 bytes                  | nA            | nanoampere                    |
| Kbit                       | 1024 bits                   | ns            | nanosecond                    |
| kHz                        | kilohertz                   | nV            | nanovolts                     |
| $\text{k}\Omega$           | kilohm                      | $\Omega$      | ohm                           |
| MHz                        | megahertz                   | pA            | picoampere                    |
| $\text{M}\Omega$           | megaohm                     | pF            | picofarad                     |
| $\mu\text{A}$              | microampere                 | pp            | peak-to-peak                  |
| $\mu\text{F}$              | microfarad                  | ppm           | parts per million             |
| $\mu\text{H}$              | microhenry                  | ps            | picosecond                    |
| $\mu\text{s}$              | microsecond                 | sps           | samples per second            |
| $\mu\text{V}$              | microvolts                  | $\sigma$      | sigma: one standard deviation |
| $\mu\text{V}_{\text{rms}}$ | microvolts root-mean-square | V             | volts                         |

### 3.1 Absolute Maximum Ratings

Table 3-2: Absolute Maximum Ratings

| Symbol            | Description   | Min                   | Typ | Max                   | Units | Notes  |
|-------------------|---|-----------------------|-----|-----------------------|-------|--|
| T <sub>STG</sub>  | Storage Temperature   | -55                   | +25 | +105                  | °C    | Higher storage temperatures will reduce data retention time. Recommended storage temperature is +25°C ± 25°C. Storage temperatures above 65°C will degrade reliability. Maximum combined storage and operational time at +105°C is 7000 hours. |
| T <sub>A</sub>    | Ambient Temperature with Power Applied                        | -40                   | —   | +105                  | °C    |  |
| V <sub>dd</sub>   | Supply Voltage on V <sub>dd</sub> Relative to V <sub>ss</sub> | -0.5                  | —   | +5.5                  | V     |  |
| V <sub>IO</sub>   | DC Input Voltage  | V <sub>ss</sub> - 0.5 | —   | V <sub>dd</sub> + 0.5 | V     |  |
| V <sub>IOZ</sub>  | DC Voltage Applied to Tri-state                               | V <sub>ss</sub> - 0.5 | —   | V <sub>dd</sub> + 0.5 | V     |  |
| I <sub>MIO</sub>  | Maximum Current into any Port Pin                             | -25                   | —   | +25                   | mA    |  |
| I <sub>MAIO</sub> | Maximum Current into any Port Pin Configured as Analog Driver | -50                   | —   | +50                   | mA    |  |
| ESD               | Static Discharge Voltage                                      | 2000                  | —   | —                     | V     | Human Body Model ESD.  |
| LU                | Latch-up Current  | —                     | —   | 200                   | mA    |  |

### 3.2 Operating Temperature

Table 3-3: Operating Temperature

| Symbol         | Description          | Min | Typ | Max  | Units | Notes  |
|----------------|----------------------|-----|-----|------|-------|--|
| T <sub>A</sub> | Ambient Temperature  | -40 | —   | +105 | °C    |  |
| T <sub>J</sub> | Junction Temperature | -40 | —   | +125 | °C    | The temperature rise from ambient to junction is package specific. See " <a href="#">Thermal Impedances per Package</a> " on page 32. The user must limit the power consumption to comply with this requirement. |

### 3.3 DC Electrical Characteristics

#### 3.3.1 DC Chip-Level Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-4: DC Chip-Level Specifications**

| Symbol              | Description  | Min  | Typ | Max  | Units | Notes  |
|---------------------|--|------|-----|------|-------|--|
| Vdd                 | Supply Voltage   | 4.75 | —   | 5.25 | V     |  |
| I <sub>DD</sub>     | Supply Current   | —    | 5   | 8    | mA    | Conditions are Vdd = 5.25V, $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ , CPU = 3 MHz, SYSCLK doubler disabled, VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 93.75 kHz, analog power = off. |
| I <sub>SB</sub>     | Sleep (Mode) Current with POR, LVD, Sleep Timer, and WDT. <sup>a</sup> | —    | 5   | 14   | μA    | Conditions are with internal slow speed oscillator, Vdd = 5.25V, $-40^{\circ}\text{C} \leq T_A \leq 55^{\circ}\text{C}$ . Analog power = off.  |
| I <sub>SBH</sub>    | Sleep (Mode) Current with POR, LVD, Sleep Timer, and WDT. <sup>a</sup> | —    | 5   | 100  | μA    | Conditions are with internal slow speed oscillator, Vdd = 5.25V, $55^{\circ}\text{C} < T_A \leq 105^{\circ}\text{C}$ . Analog power = off.   |
| I <sub>SBXTL</sub>  | Sleep (Mode) Current with POR, LVD, Sleep Timer, and WDT. <sup>a</sup> | —    | 7   | 16   | μA    | Conditions are with properly loaded, 1 μW max, 32.768 kHz crystal. Vdd = 5.25V, $-40^{\circ}\text{C} \leq T_A \leq 55^{\circ}\text{C}$ . Analog power = off.                                     |
| I <sub>SBXTLH</sub> | Sleep (Mode) Current with POR, LVD, Sleep Timer, and WDT. <sup>a</sup> | —    | 7   | 100  | μA    | Conditions are with properly loaded, 1 μW max, 32.768 kHz crystal. Vdd = 5.25V, $55^{\circ}\text{C} < T_A \leq 105^{\circ}\text{C}$ . Analog power = off.  |
| V <sub>REF</sub>    | Reference Voltage (Bandgap)  | 1.25 | 1.3 | 1.35 | V     | Trimmed for appropriate Vdd.   |

a. Standby current includes all functions (POR, LVD, WDT, Sleep Time) needed for reliable system operation. This should be compared with devices that have similar functions enabled.

#### 3.3.2 DC General Purpose IO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-5: DC GPIO Specifications**

| Symbol           | Description                       | Min | Typ | Max  | Units | Notes  |
|------------------|-----------------------------------|-----|-----|------|-------|--|
| R <sub>PU</sub>  | Pull up Resistor                  | 4   | 5.6 | 8    | kΩ    |  |
| R <sub>PD</sub>  | Pull down Resistor                | 4   | 5.6 | 8    | kΩ    |  |
| V <sub>OH</sub>  | High Output Level                 | 3.5 | —   | —    | V     | IOH = 10 mA, Vdd = 4.75 to 5.25V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). |
| V <sub>OL</sub>  | Low Output Level                  | —   | —   | 0.75 | V     | IOL = 25 mA, Vdd = 4.75 to 5.25V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). |
| V <sub>IL</sub>  | Input Low Level                   | —   | —   | 0.8  | V     | Vdd = 4.75 to 5.25.  |
| V <sub>IH</sub>  | Input High Level                  | 2.2 | —   | —    | V     | Vdd = 4.75 to 5.25.  |
| V <sub>H</sub>   | Input Hysteresis                  | —   | 110 | —    | mV    |  |
| I <sub>IL</sub>  | Input Leakage (Absolute Value)    | —   | 1   | —    | nA    | Gross tested to 1 μA.  |
| C <sub>IN</sub>  | Capacitive Load on Pins as Input  | —   | 3.5 | 10   | pF    | Package and pin dependent. Temp = 25°C.  |
| C <sub>OUT</sub> | Capacitive Load on Pins as Output | —   | 3.5 | 10   | pF    | Package and pin dependent. Temp = 25°C.  |

### 3.3.3 DC Operational Amplifier Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance.

The Operational Amplifier is a component of both the Analog Continuous Time PSoC blocks and the Analog Switched Cap PSoC blocks. The guaranteed specifications are measured in the Analog Continuous Time PSoC block.

**Table 3-6: DC Operational Amplifier Specifications**

| Symbol        | Description   | Min            | Typ  | Max            | Units                          | Notes   |
|---------------|---|----------------|------|----------------|--------------------------------|---|
| $V_{OSOA}$    | Input Offset Voltage (absolute value) Low Power           | –              | 1.6  | 11             | mV                             |   |
|               | Input Offset Voltage (absolute value) Mid Power           | –              | 1.3  | 9              | mV                             |   |
|               | Input Offset Voltage (absolute value) High Power          | –              | 1.2  | 9              | mV                             |   |
| $TCV_{OSOA}$  | Input Offset Voltage Drift                                | –              | 7.0  | 35.0           | $\mu\text{V}/^{\circ}\text{C}$ |   |
| $I_{EBOA}$    | Input Leakage Current (Port 0 Analog Pins)                | –              | 10   | 200            | pA                             |   |
| $C_{INOA}$    | Input Capacitance (Port 0 Analog Pins)                    | –              | 4.5  | 10             | pF                             | Package and pin dependent. Temp = $25^{\circ}\text{C}$ .  |
| $V_{CMOA}$    | Common Mode Voltage Range                                 | 0.0            | –    | $V_{dd}$       | V                              | The common-mode input voltage range is measured through an analog output buffer. The specification includes the limitations imposed by the characteristics of the analog output buffer. |
|               | Common Mode Voltage Range (high power or high opamp bias) | 0.5            | –    | $V_{dd} - 0.5$ | V                              |   |
| $G_{LOOA}$    | Open Loop Gain  | –              | –    | –              | dB                             | Specification is applicable at high power. For all other bias modes (except high power, high opamp bias), minimum is 60 dB.   |
|               | Power=Low   |                | 80   |                |                                |   |
|               | Power=Medium  |                | 80   |                |                                |   |
|               | Power=High  |                | 80   |                |                                |   |
| $V_{OHIGHOA}$ | High Output Voltage Swing (worst case internal load)      |                |      |                |                                |   |
|               | Power=Low   | $V_{dd} - 0.2$ | –    | –              | V                              |   |
|               | Power=Medium  | $V_{dd} - 0.2$ | –    | –              | V                              |   |
|               | Power=High  | $V_{dd} - 0.5$ | –    | –              | V                              |   |
| $V_{OLOWOA}$  | Low Output Voltage Swing (worst case internal load)       |                |      |                |                                |   |
|               | Power=Low   | –              | –    | 0.2            | V                              |   |
|               | Power=Medium  | –              | –    | 0.2            | V                              |   |
|               | Power=High  | –              | –    | 0.5            | V                              |   |
| $I_{SOA}$     | Supply Current (including associated AGND buffer)         |                |      |                |                                |   |
|               | Power=Low   | –              | 150  | 200            | $\mu\text{A}$                  |   |
|               | Power=Low, Opamp Bias=High                                | –              | 300  | 400            | $\mu\text{A}$                  |   |
|               | Power=Medium  | –              | 600  | 800            | $\mu\text{A}$                  |   |
|               | Power=Medium, Opamp Bias=High                             | –              | 1200 | 1600           | $\mu\text{A}$                  |   |
|               | Power=High  | –              | 2400 | 3200           | $\mu\text{A}$                  |   |
| $PSRR_{OA}$   | Power=High, Opamp Bias=High                               | –              | 4600 | 6400           | $\mu\text{A}$                  |   |
|               | Supply Voltage Rejection Ratio                            | –              | 80   | –              | dB                             | $V_{ss} \leq V_{IN} \leq (V_{dd} - 2.25) \text{ or } (V_{dd} - 1.25) \leq V_{IN} \leq V_{dd}$ .   |

### 3.3.4 DC Low Power Comparator Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-7. DC Low Power Comparator Specifications**

| Symbol       | Description  | Min | Typ | Max          | Units         | Notes |
|--------------|--|-----|-----|--------------|---------------|-------|
| $V_{REFLPC}$ | Low power comparator (LPC) reference voltage range | 0.2 | –   | $V_{dd} - 1$ | V             |       |
| $I_{SLPC}$   | LPC supply current                                 | –   | 10  | 40           | $\mu\text{A}$ |       |
| $V_{OSLPC}$  | LPC voltage offset                                 | –   | 2.5 | 30           | mV            |       |

### 3.3.5 DC Analog Output Buffer Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-8: DC Analog Output Buffer Specifications**

| Symbol               | Description  | Min                             | Typ | Max                             | Units                          | Notes |
|----------------------|--|---------------------------------|-----|---------------------------------|--------------------------------|-------|
| $V_{\text{OSOB}}$    | Input Offset Voltage (Absolute Value)                            | –                               | 3   | 18                              | mV                             |       |
| $TCV_{\text{OSOB}}$  | Input Offset Voltage Drift                                       | –                               | +6  | –                               | $\mu\text{V}/^{\circ}\text{C}$ |       |
| $V_{\text{CMOB}}$    | Common-Mode Input Voltage Range                                  | .5                              | –   | $V_{\text{dd}} - 1.0$           | V                              |       |
| $R_{\text{OUTOB}}$   | Output Resistance  | –                               | 1   | –                               | $\Omega$                       |       |
| $V_{\text{OHIGHOB}}$ | High Output Voltage Swing (Load = 32 ohms to $V_{\text{dd}}/2$ ) | $.5 \times V_{\text{dd}} + 1.3$ | –   | –                               | V                              |       |
| $V_{\text{OLOWOB}}$  | Low Output Voltage Swing (Load = 32 ohms to $V_{\text{dd}}/2$ )  | –                               | –   | $.5 \times V_{\text{dd}} - 1.3$ | V                              |       |
| $I_{\text{SOB}}$     | Supply Current Including Bias Cell (No Load)                     | –                               | 1.1 | 5.1                             | mA                             |       |
|                      | Power = Low  | –                               | 2.6 | 8.8                             | mA                             |       |
| $PSRR_{\text{OB}}$   | Supply Voltage Rejection Ratio                                   | –                               | 64  | –                               | dB                             |       |

### 3.3.6 DC Analog Reference Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_{\text{A}} \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

The guaranteed specifications are measured through the Analog Continuous Time PSoC blocks. The power levels for AGND refer to the power of the Analog Continuous Time PSoC block. The power levels for RefHi and RefLo refer to the Analog Reference Control register. The limits stated for AGND include the offset error of the AGND buffer local to the Analog Continuous Time PSoC block.

**Table 3-9: DC Analog Reference Specifications**

| Symbol           | Description   | Min                      | Typ                      | Max                      | Units |
|------------------|---|--------------------------|--------------------------|--------------------------|-------|
| $V_{\text{BG5}}$ | Bandgap Voltage Reference 5V  | 1.25                     | 1.30                     | 1.35                     | V     |
| -                | $\text{AGND} = V_{\text{dd}}/2^{\text{a}}$<br>CT Block Power = High                                       | $V_{\text{dd}}/2 - 0.02$ | $V_{\text{dd}}/2$        | $V_{\text{dd}}/2 + 0.02$ | V     |
| -                | $\text{AGND} = 2 \times \text{BandGap}^{\text{a}}$<br>CT Block Power = High                               | 2.4                      | 2.60                     | 2.8                      | V     |
| -                | $\text{AGND} = P2[4] (P2[4] = V_{\text{dd}}/2)^{\text{a}}$<br>CT Block Power = High                       | $P2[4] - 0.02$           | $P2[4]$                  | $P2[4] + 0.02$           | V     |
| -                | $\text{AGND} = \text{BandGap}^{\text{a}}$<br>CT Block Power = High  | 1.23                     | 1.3                      | 1.37                     | V     |
| -                | $\text{AGND} = 1.6 \times \text{BandGap}^{\text{a}}$<br>CT Block Power = High                             | 1.98                     | 2.08                     | 2.14                     | V     |
| -                | AGND Column to Column Variation ( $\text{AGND}=V_{\text{dd}}/2$ )<br>CT Block Power = High                | -0.035                   | 0.000                    | 0.035                    | V     |
| -                | $\text{RefHi} = V_{\text{dd}}/2 + \text{BandGap}$<br>Ref Control Power = High                             | $V_{\text{dd}}/2 + 1.15$ | $V_{\text{dd}}/2 + 1.30$ | $V_{\text{dd}}/2 + 1.45$ | V     |
| -                | $\text{RefHi} = 3 \times \text{BandGap}$<br>Ref Control Power = High                                      | 3.65                     | 3.9                      | 4.15                     | V     |
| -                | $\text{RefHi} = 2 \times \text{BandGap} + P2[6] (P2[6] = 1.3\text{V})$<br>Ref Control Power = High        | $P2[6] + 2.4$            | $P2[6] + 2.6$            | $P2[6] + 2.8$            | V     |
| -                | $\text{RefHi} = P2[4] + \text{BandGap} (P2[4] = V_{\text{dd}}/2)$<br>Ref Control Power = High             | $P2[4] + 1.24$           | $P2[4] + 1.30$           | $P2[4] + 1.36$           | V     |
| -                | $\text{RefHi} = P2[4] + P2[6] (P2[4] = V_{\text{dd}}/2, P2[6] = 1.3\text{V})$<br>Ref Control Power = High | $P2[4] + P2[6] - 0.1$    | $P2[4] + P2[6]$          | $P2[4] + P2[6] + 0.1$    | V     |
| -                | $\text{RefHi} = 2 \times \text{BandGap}$<br>Ref Control Power = High                                      | 2.4                      | 2.60                     | 2.8                      | V     |
| -                | $\text{RefHi} = 3.2 \times \text{BandGap}$<br>Ref Control Power = High                                    | 3.9                      | 4.16                     | 4.42                     | V     |
| -                | $\text{RefLo} = V_{\text{dd}}/2 - \text{BandGap}$<br>Ref Control Power = High                             | $V_{\text{dd}}/2 - 1.45$ | $V_{\text{dd}}/2 - 1.3$  | $V_{\text{dd}}/2 - 1.15$ | V     |
| -                | $\text{RefLo} = \text{BandGap}$<br>Ref Control Power = High   | 1.15                     | 1.30                     | 1.45                     | V     |
| -                | $\text{RefLo} = 2 \times \text{BandGap} - P2[6] (P2[6] = 1.3\text{V})$<br>Ref Control Power = High        | $2.4 - P2[6]$            | $2.6 - P2[6]$            | $2.8 + P2[6]$            | V     |
| -                | $\text{RefLo} = P2[4] - \text{BandGap} (P2[4] = V_{\text{dd}}/2)$<br>Ref Control Power = High             | $P2[4] - 1.45$           | $P2[4] - 1.3$            | $P2[4] - 1.15$           | V     |
| -                | $\text{RefLo} = P2[4] - P2[6] (P2[4] = V_{\text{dd}}/2, P2[6] = 1.3\text{V})$<br>Ref Control Power = High | $P2[4] - P2[6] - 0.1$    | $P2[4] - P2[6]$          | $P2[4] - P2[6] + 0.1$    | V     |

a. AGND tolerance includes the offsets of the local buffer in the PSoC block. BG = Bandgap voltage is  $1.3\text{V} \pm 0.05\text{V}$ .

### 3.3.7 DC Analog PSoC Block Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-10: DC Analog PSoC Block Specifications**

| Symbol   | Description                               | Min | Typ   | Max | Units      | Notes |
|----------|---|-----|-------|-----|------------|-------|
| $R_{CT}$ | Resistor Unit Value (Continuous Time)     | –   | 12.24 | –   | k $\Omega$ |       |
| $C_{SC}$ | Capacitor Unit Value (Switched Capacitor) | –   | 80    | –   | fF         |       |

### 3.3.8 DC POR and LVD Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-11: DC POR and LVD Specifications**

| Symbol       | Description                             | Min  | Typ  | Max  | Units | Notes |
|--------------|---|------|------|------|-------|-------|
| $V_{PPOR1R}$ | Vdd Value for PPOR Trip (positive ramp) | –    | 4.40 | –    | V     |       |
| $V_{PPOR2R}$ | PORLEV[1:0] = 01b<br>PORLEV[1:0] = 10b  | –    | 4.60 | –    | V     |       |
| $V_{PPOR1}$  | Vdd Value for PPOR Trip (negative ramp) | –    | 4.40 | –    | V     |       |
| $V_{PPOR2}$  | PORLEV[1:0] = 01b<br>PORLEV[1:0] = 10b  | –    | 4.60 | –    | V     |       |
| $V_{PH1}$    | PPOR Hysteresis                         | –    | 0    | –    | mV    |       |
| $V_{PH2}$    | PORLEV[1:0] = 01b<br>PORLEV[1:0] = 10b  | –    | 0    | –    | mV    |       |
| $V_{LVD6}$   | Vdd Value for LVD Trip                  | 4.54 | 4.80 | 4.92 | V     |       |
| $V_{LVD7}$   | VM[2:0] = 110b<br>VM[2:0] = 111b        | 4.63 | 4.90 | 5.01 | V     |       |

### 3.3.9 DC Programming Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-12: DC Programming Specifications**

| Symbol                | Description  | Min    | Typ | Max             | Units | Notes                                |
|-----------------------|--|--------|-----|-----------------|-------|--------------------------------------|
| $I_{DDP}$             | Supply Current During Programming or Verify  | –      | 15  | 25              | mA    |                                      |
| $V_{ILP}$             | Input Low Voltage During Programming or Verify                                       | –      | –   | 0.8             | V     |                                      |
| $V_{IHP}$             | Input High Voltage During Programming or Verify                                      | 2.2    | –   | –               | V     |                                      |
| $I_{ILP}$             | Input Current when Applying $V_{ILP}$ to P1[0] or P1[1] During Programming or Verify | –      | –   | 0.2             | mA    | Driving internal pull-down resistor. |
| $I_{IHP}$             | Input Current when Applying $V_{IHP}$ to P1[0] or P1[1] During Programming or Verify | –      | –   | 1.5             | mA    | Driving internal pull-down resistor. |
| $V_{OLV}$             | Output Low Voltage During Programming or Verify                                      | –      | –   | $V_{SS} + 0.75$ | V     |                                      |
| $V_{OHV}$             | Output High Voltage During Programming or Verify                                     | 3.5    | –   | $V_{DD}$        | V     |                                      |
| $\text{Flash}_{ENPB}$ | Flash Endurance (per block) <sup>a</sup>   | 100    | –   | –               | –     | Erase/write cycles per block.        |
| $\text{Flash}_{ENT}$  | Flash Endurance (total) <sup>a,b</sup>   | 25,600 | –   | –               | –     | Erase/write cycles.                  |
| $\text{Flash}_{DR}$   | Flash Data Retention <sup>c</sup>  | 15     | –   | –               | Years |                                      |

- a. For the full temperature range, the user must employ a temperature sensor user module (FlashTemp) and feed the result to the temperature argument before writing. Refer to the Flash APIs Application Note AN2015 at <http://www.cypress.com> under Application Notes for more information.
- b. A maximum of  $256 \times 100$  block endurance cycles is allowed.
- c. Flash data retention based on the use condition of  $\leq 7000$  hours at  $T_A \leq 105^{\circ}\text{C}$  and the remaining time at  $T_A \leq 65^{\circ}\text{C}$ .

## 3.4 AC Electrical Characteristics

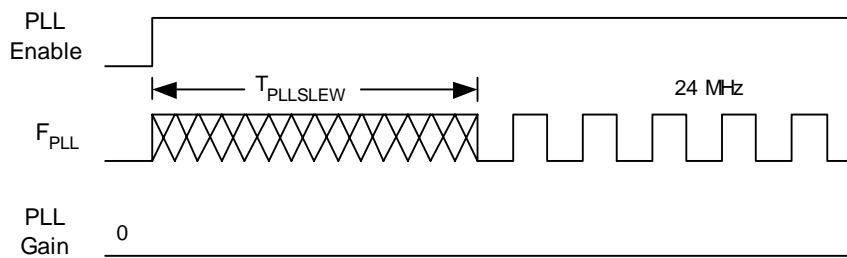
### 3.4.1 AC Chip-Level Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-13: AC Chip-Level Specifications**

| Symbol             | Description   | Min   | Typ    | Max                | Units         | Notes  |
|--------------------|---|-------|--------|--------------------|---------------|--|
| $F_{IMO24}$        | Internal Main Oscillator Frequency for 24 MHz           | 22.95 | 24     | 24.96              | MHz           | Trimmed. Utilizing factory trim values.      |
| $F_{CPU1}$         | CPU Frequency (5V Nominal)                              | 0.90  | 12     | 12.48              | MHz           |  |
| $F_{48M}$          | Digital PSOC Block Frequency                            | —     | —      | —                  | MHz           | Not allowed.                                 |
| $F_{24M}$          | Digital PSOC Block Frequency                            | 0     | 24     | 24.96 <sup>a</sup> | MHz           |  |
| $F_{32K1}$         | Internal Low Speed Oscillator Frequency                 | 15    | 32     | 64                 | kHz           |  |
| $F_{32K2}$         | External Crystal Oscillator                             | —     | 32.768 | —                  | kHz           | Accuracy is capacitor and crystal dependent. |
| $F_{PLL}$          | PLL Frequency   | —     | 23.986 | —                  | MHz           | Is a multiple (x732) of crystal frequency.   |
| Jitter24M2         | 24 MHz Period Jitter (PLL)                              | —     | —      | 800                | ps            |  |
| $T_{PLLSLEW}$      | PLL Lock Time   | 0.5   | —      | 10                 | ms            |  |
| $T_{PLLSLEWS-LOW}$ | PLL Lock Time for Low Gain Setting                      | 0.5   | —      | 50                 | ms            |  |
| $T_{OS}$           | External Crystal Oscillator Startup to 1%               | —     | 1700   | 2620               | ms            |  |
| $T_{OSACC}$        | External Crystal Oscillator Startup to 200 ppm          | —     | 2800   | 3800               | ms            |  |
| Jitter32k          | 32 kHz Period Jitter                                    | —     | 100    | —                  | ns            |  |
| $T_{XRST}$         | External Reset Pulse Width                              | 10    | —      | —                  | $\mu\text{s}$ |  |
| DC24M              | 24 MHz Duty Cycle                                       | 40    | 50     | 60                 | %             |  |
| Step24M            | 24 MHz Trim Step Size                                   | —     | 50     | —                  | kHz           |  |
| Jitter24M1P        | 24 MHz Period Jitter (IMO) Peak-to-Peak                 | —     | 300    | —                  | ps            |  |
| Jitter24M1R        | 24 MHz Period Jitter (IMO) Root Mean Squared            | —     | —      | 600                | ps            |  |
| $F_{MAX}$          | Maximum frequency of signal on row input or row output. | —     | —      | 12.48              | MHz           |  |
| $T_{RAMP}$         | Supply Ramp Time  | 0     | —      | —                  | $\mu\text{s}$ |  |

a. See the individual user module data sheets for information on maximum frequencies for user modules.



**Figure 3-2. PLL Lock Timing Diagram**

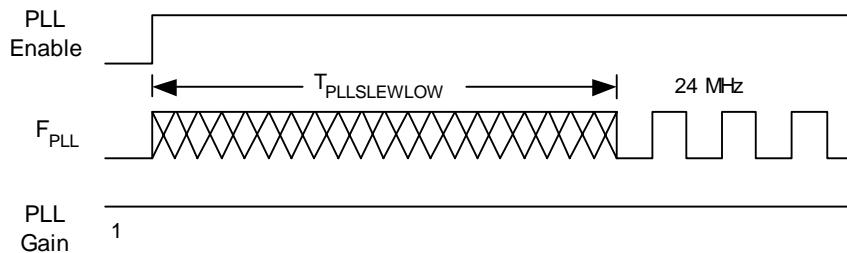


Figure 3-3. PLL Lock for Low Gain Setting Timing Diagram

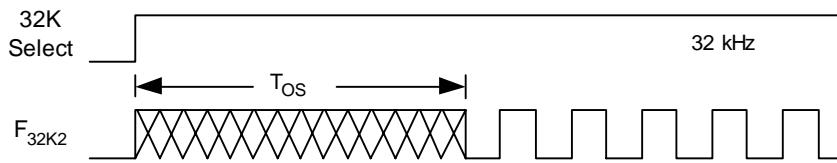


Figure 3-4. External Crystal Oscillator Startup Timing Diagram



Figure 3-5. 24 MHz Period Jitter (IMO) Timing Diagram

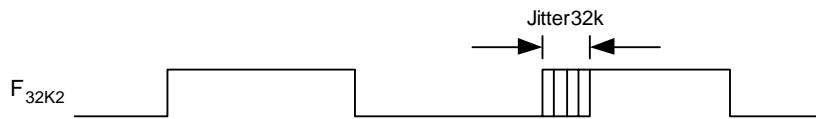


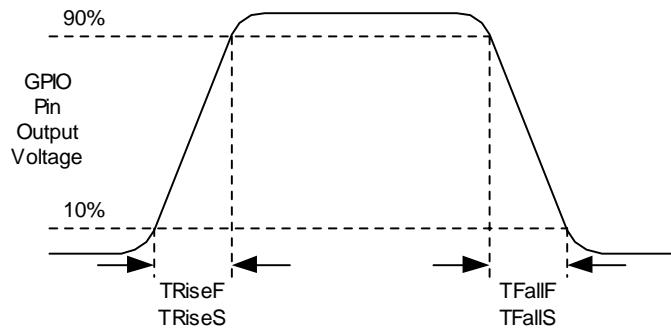
Figure 3-6. 32 kHz Period Jitter (ECO) Timing Diagram

### 3.4.2 AC General Purpose IO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-14: AC GPIO Specifications**

| Symbol            | Description                                  | Min | Typ | Max   | Units | Notes                          |
|-------------------|--|-----|-----|-------|-------|--------------------------------|
| $F_{\text{GPIO}}$ | GPIO Operating Frequency                     | 0   | –   | 12.48 | MHz   | Normal Strong Mode             |
| $\text{TRiseF}$   | Rise Time, Normal Strong Mode, Cload = 50 pF | 3   | –   | 22    | ns    | Vdd = 4.75 to 5.25V, 10% - 90% |
| $\text{TFallF}$   | Fall Time, Normal Strong Mode, Cload = 50 pF | 2   | –   | 22    | ns    | Vdd = 4.75 to 5.25V, 10% - 90% |
| $\text{TRiseS}$   | Rise Time, Slow Strong Mode, Cload = 50 pF   | 9   | 27  | –     | ns    | Vdd = 4.75 to 5.25V, 10% - 90% |
| $\text{TFallS}$   | Fall Time, Slow Strong Mode, Cload = 50 pF   | 9   | 22  | –     | ns    | Vdd = 4.75 to 5.25V, 10% - 90% |



**Figure 3-7. GPIO Timing Diagram**

### 3.4.3 AC Operational Amplifier Specifications

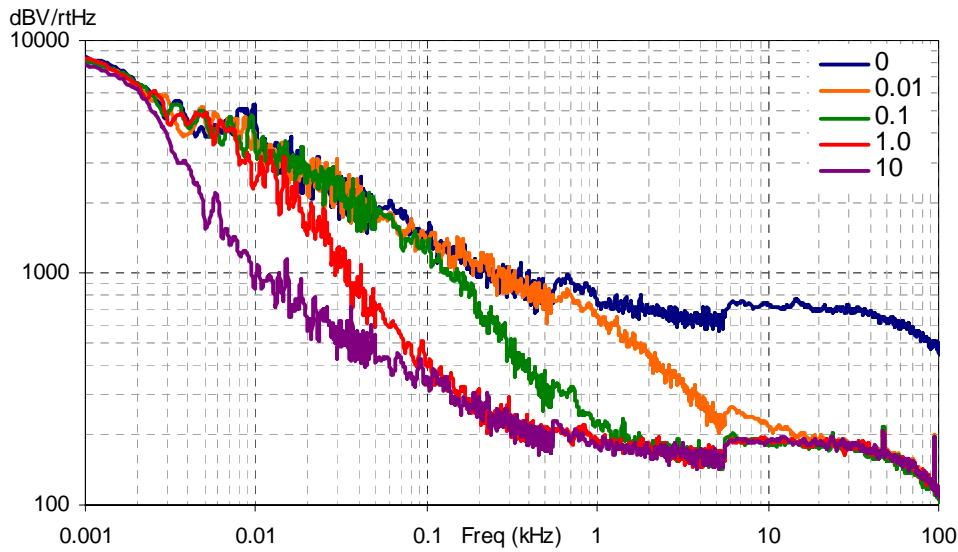
The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

Settling times, slew rates, and gain bandwidth are based on the Analog Continuous Time PSoC block.

**Table 3-15: AC Operational Amplifier Specifications**

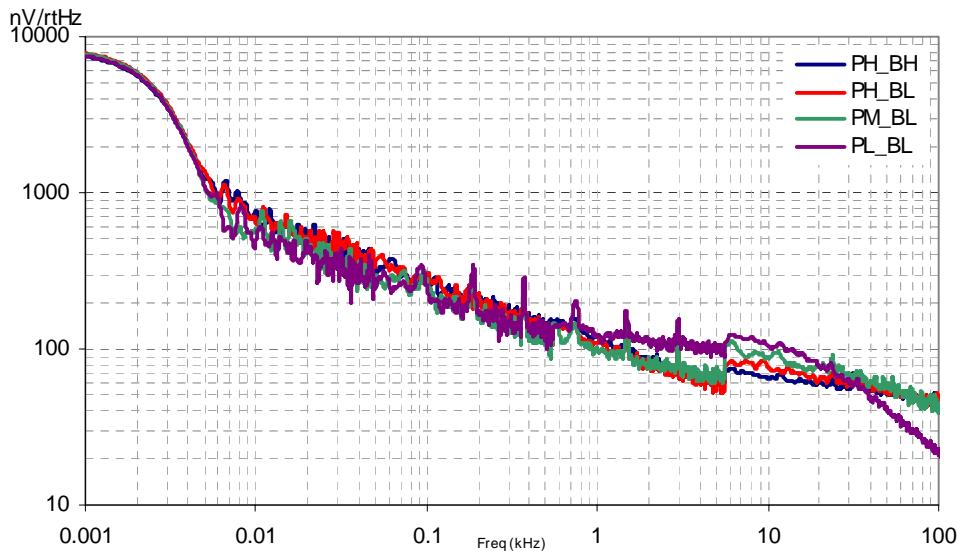
| Symbol                   | Description  | Min  | Typ | Max | Units            | Notes |
|--------------------------|--|------|-----|-----|------------------|-------|
| $\text{SR}_{\text{ROA}}$ | Rising Slew Rate (20% to 80%)(10 pF load, Unity Gain)  |      |     |     |                  |       |
|                          | Power = Low  | 0.15 | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = Low, Opamp Bias = High                         | 0.15 | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = Medium   | 0.15 | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = Medium, Opamp Bias = High                      | 1.7  | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = High   | 1.7  | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = High, Opamp Bias = High                        | 6.5  | —   |     | V/ $\mu\text{s}$ |       |
| $\text{SR}_{\text{FOA}}$ | Falling Slew Rate (20% to 80%)(10 pF load, Unity Gain) |      |     |     |                  |       |
|                          | Power = Low  | 0.01 | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = Low, Opamp Bias = High                         | 0.01 | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = Medium   | 0.01 | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = Medium, Opamp Bias = High                      | 0.5  | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = High   | 0.5  | —   |     | V/ $\mu\text{s}$ |       |
|                          | Power = High, Opamp Bias = High                        | 4.0  | —   |     | V/ $\mu\text{s}$ |       |
| $\text{BW}_{\text{OA}}$  | Gain Bandwidth Product                                 |      |     |     |                  |       |
|                          | Power = Low  | 0.75 | —   |     | MHz              |       |
|                          | Power = Low, Opamp Bias = High                         | 0.75 | —   |     | MHz              |       |
|                          | Power = Medium   | 0.75 | —   |     | MHz              |       |
|                          | Power = Medium, Opamp Bias = High                      | 3.1  | —   |     | MHz              |       |
|                          | Power = High   | 3.1  | —   |     | MHz              |       |
|                          | Power = High, Opamp Bias = High                        | 5.4  | —   |     | MHz              |       |

When bypassed by a capacitor on P2[4], the noise of the analog ground signal distributed to each block is reduced by a factor of up to 5 (14 dB). This is at frequencies above the corner frequency defined by the on-chip 8.1k resistance and the external capacitor.



**Figure 3-8. Typical AGND Noise with P2[4] Bypass**

At low frequencies, the opamp noise is proportional to 1/f, power independent, and determined by device geometry. At high frequencies, increased power level reduces the noise spectrum level.



**Figure 3-9. Typical Opamp Noise**

### 3.4.4 AC Low Power Comparator Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-16. AC Low Power Comparator Specifications**

| Symbol     | Description       | Min | Typ | Max | Units | Notes   |
|------------|-------------------|-----|-----|-----|-------|---|
| $T_{RLPC}$ | LPC response time | —   | —   | 50  | μs    | $\geq 50$ mV overdrive comparator reference set within $V_{REFLPC}$ . |

### 3.4.5 AC Digital Block Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-17: AC Digital Block Specifications**

| Function          | Description                                | Min             | Typ | Max   | Units | Notes   |
|-------------------|--|-----------------|-----|-------|-------|---|
| All Functions     | Maximum Block Clocking Frequency (> 4.75V) |                 |     | 24.96 |       | $4.75\text{V} < V_{dd} < 5.25\text{V}$ .                |
| Timer             | Capture Pulse Width                        | 50 <sup>a</sup> | —   | —     | ns    |   |
|                   | Maximum Frequency, No Capture              | —               | —   | 24.96 | MHz   | $4.75\text{V} < V_{dd} < 5.25\text{V}$ .                |
|                   | Maximum Frequency, With Capture            | —               | —   | 24.96 | MHz   |   |
| Counter           | Enable Pulse Width                         | 50 <sup>a</sup> | —   | —     | ns    |   |
|                   | Maximum Frequency, No Enable Input         | —               | —   | 24.96 | MHz   | $4.75\text{V} < V_{dd} < 5.25\text{V}$ .                |
|                   | Maximum Frequency, Enable Input            | —               | —   | 24.96 | MHz   |   |
| Dead Band         | Kill Pulse Width:                          |                 |     |       |       |   |
|                   | Asynchronous Restart Mode                  | 20              | —   | —     | ns    |   |
|                   | Synchronous Restart Mode                   | 50 <sup>a</sup> | —   | —     | ns    |   |
|                   | Disable Mode                               | 50 <sup>a</sup> | —   | —     | ns    |   |
|                   | Maximum Frequency                          | —               | —   | 24.96 | MHz   | $4.75\text{V} < V_{dd} < 5.25\text{V}$ .                |
| CRCPRS (PRS Mode) | Maximum Input Clock Frequency              | —               | —   | 24.96 | MHz   | $4.75\text{V} < V_{dd} < 5.25\text{V}$ .                |
| CRCPRS (CRC Mode) | Maximum Input Clock Frequency              | —               | —   | 24.96 | MHz   |   |
| SPIM              | Maximum Input Clock Frequency              | —               | —   | 4     | MHz   | Maximum data rate at 4.1 MHz due to 2 x over clocking.  |
| SPIS              | Maximum Input Clock Frequency              | —               | —   | 2     | MHz   |   |
|                   | Width of SS_ Negated Between Transmissions | 50 <sup>a</sup> | —   | —     | ns    |   |
| Transmitter       | Maximum Input Clock Frequency              | —               | —   | 8     | MHz   | Maximum data rate at 3.08 MHz due to 8 x over clocking. |
| Receiver          | Maximum Input Clock Frequency              | —               | 16  | 24.96 | MHz   | Maximum data rate at 3.08 MHz due to 8 x over clocking. |

a. 50 ns minimum input pulse width is based on the input synchronizers running at 24 MHz (42 ns nominal period).

### 3.4.6 AC Analog Output Buffer Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-18: AC Analog Output Buffer Specifications**

| Symbol            | Description  | Min | Typ | Max | Units                  | Notes |
|-------------------|--|-----|-----|-----|------------------------|-------|
| $T_{\text{ROB}}$  | Rising Settling Time to 0.1%, 1V Step, 100pF Load<br>Power = Low               | —   | —   | 3   | $\mu\text{s}$          |       |
|                   | Power = High   | —   | —   | 3   | $\mu\text{s}$          |       |
| $T_{\text{SOB}}$  | Falling Settling Time to 0.1%, 1V Step, 100pF Load<br>Power = Low              | —   | —   | 3   | $\mu\text{s}$          |       |
|                   | Power = High   | —   | —   | 3   | $\mu\text{s}$          |       |
| $SR_{\text{ROB}}$ | Rising Slew Rate (20% to 80%), 1V Step, 100pF Load<br>Power = Low              | 0.6 | —   | —   | $\text{V}/\mu\text{s}$ |       |
|                   | Power = High   | 0.6 | —   | —   | $\text{V}/\mu\text{s}$ |       |
|                   | Falling Slew Rate (80% to 20%), 1V Step, 100pF Load<br>Power = Low             | 0.6 | —   | —   | $\text{V}/\mu\text{s}$ |       |
| $SR_{\text{FOB}}$ | Power = High   | 0.6 | —   | —   | $\text{V}/\mu\text{s}$ |       |
|                   | Small Signal Bandwidth, 20mV <sub>pp</sub> , 3dB BW, 100pF Load<br>Power = Low | 0.8 | —   | —   | MHz                    |       |
| $BW_{\text{OB}}$  | Power = High   | 0.8 | —   | —   | MHz                    |       |
|                   | Large Signal Bandwidth, 1V <sub>pp</sub> , 3dB BW, 100pF Load<br>Power = Low   | 300 | —   | —   | kHz                    |       |
|                   | Power = High   | 300 | —   | —   | kHz                    |       |

### 3.4.7 AC External Clock Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-19: AC External Clock Specifications**

| Symbol              | Description            | Min  | Typ | Max   | Units         | Notes |
|---------------------|------------------------|------|-----|-------|---------------|-------|
| $F_{\text{OSCEXT}}$ | Frequency              | 0    | —   | 24.24 | MHz           |       |
| —                   | High Period            | 20.6 | —   | —     | ns            |       |
| —                   | Low Period             | 20.6 | —   | —     | ns            |       |
| —                   | Power Up IMO to Switch | 150  | —   | —     | $\mu\text{s}$ |       |

### 3.4.8 AC Programming Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-20: AC Programming Specifications**

| Symbol       | Description                              | Min | Typ | Max | Units | Notes |
|--------------|--|-----|-----|-----|-------|-------|
| $T_{RSCLK}$  | Rise Time of SCLK                        | 1   | —   | 20  | ns    |       |
| $T_{FSCLK}$  | Fall Time of SCLK                        | 1   | —   | 20  | ns    |       |
| $T_{SSCLK}$  | Data Set up Time to Falling Edge of SCLK | 40  | —   | —   | ns    |       |
| $T_{HSCLK}$  | Data Hold Time from Falling Edge of SCLK | 40  | —   | —   | ns    |       |
| $F_{SCLK}$   | Frequency of SCLK                        | 0   | —   | 8   | MHz   |       |
| $T_{ERASEB}$ | Flash Erase Time (Block)                 | —   | 15  | —   | ms    |       |
| $T_{WRITE}$  | Flash Block Write Time                   | —   | 30  | —   | ms    |       |
| $T_{DSCLK}$  | Data Out Delay from Falling Edge of SCLK | —   | —   | 45  | ns    |       |

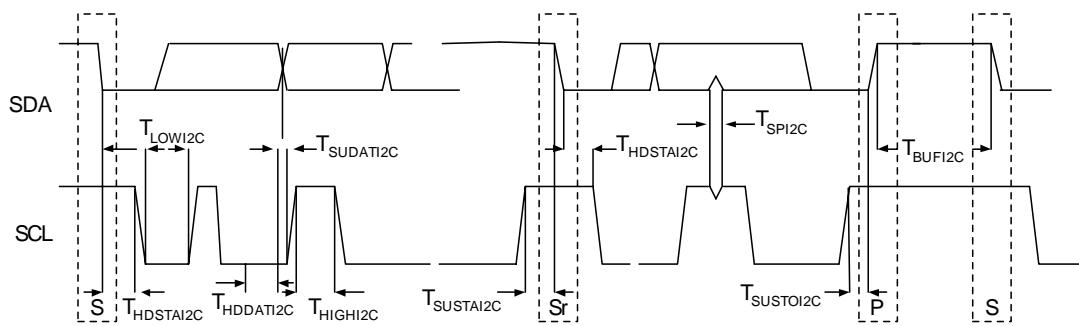
### 3.4.9 AC I<sup>2</sup>C Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \leq T_A \leq 105^{\circ}\text{C}$ . Typical parameters apply to 5V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 3-21: AC Characteristics of the I<sup>2</sup>C SDA and SCL Pins**

| Symbol         | Description  | Standard Mode |     | Fast Mode        |     | Units | Notes |
|----------------|--|---------------|-----|------------------|-----|-------|-------|
|                |  | Min           | Max | Min              | Max |       |       |
| $F_{SCLI2C}$   | SCL Clock Frequency  | 0             | 100 | 0                | 400 | kHz   |       |
| $T_{HDSTA12C}$ | Hold Time (repeated) START Condition. After this period, the first clock pulse is generated. | 4.0           | —   | 0.6              | —   | μs    |       |
| $T_{LOWI2C}$   | LOW Period of the SCL Clock  | 4.7           | —   | 1.3              | —   | μs    |       |
| $T_{HIGHI2C}$  | HIGH Period of the SCL Clock   | 4.0           | —   | 0.6              | —   | μs    |       |
| $T_{SUSTAI2C}$ | Set-up Time for a Repeated START Condition   | 4.7           | —   | 0.6              | —   | μs    |       |
| $T_{HDDATI2C}$ | Data Hold Time   | 0             | —   | 0                | —   | μs    |       |
| $T_{SUDATI2C}$ | Data Set-up Time   | 250           | —   | 100 <sup>a</sup> | —   | ns    |       |
| $T_{SUSTOI2C}$ | Set-up Time for STOP Condition   | 4.0           | —   | 0.6              | —   | μs    |       |
| $T_{BUFI2C}$   | Bus Free Time Between a STOP and START Condition   | 4.7           | —   | 1.3              | —   | μs    |       |
| $T_{SPII2C}$   | Pulse Width of spikes are suppressed by the input filter.                                    | —             | —   | 0                | 50  | ns    |       |

a. A Fast-Mode I<sup>2</sup>C-bus device can be used in a Standard-Mode I<sup>2</sup>C-bus system, but the requirement  $t_{SU:DAT} \geq 250$  ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_{fmax} + t_{SU:DAT} = 1000 + 250 = 1250$  ns (according to the Standard-Mode I<sup>2</sup>C-bus specification) before the SCL line is released.



**Figure 3-10. Definition for Timing for Fast/Standard Mode on the I<sup>2</sup>C Bus**

# 4. Packaging Information



This chapter illustrates the packaging specifications for the CY8C27x43 automotive PSoC device, along with the thermal impedances for each package and the typical package capacitance on crystal pins.

**Important Note** Emulation tools may require a larger area on the target PCB than the chip's footprint. For a detailed description of the emulation tools' dimensions, refer to the document titled *PSoC Emulator Pod Dimensions* at <http://www.cypress.com/design/MR10161>.

## 4.1 Packaging Dimensions

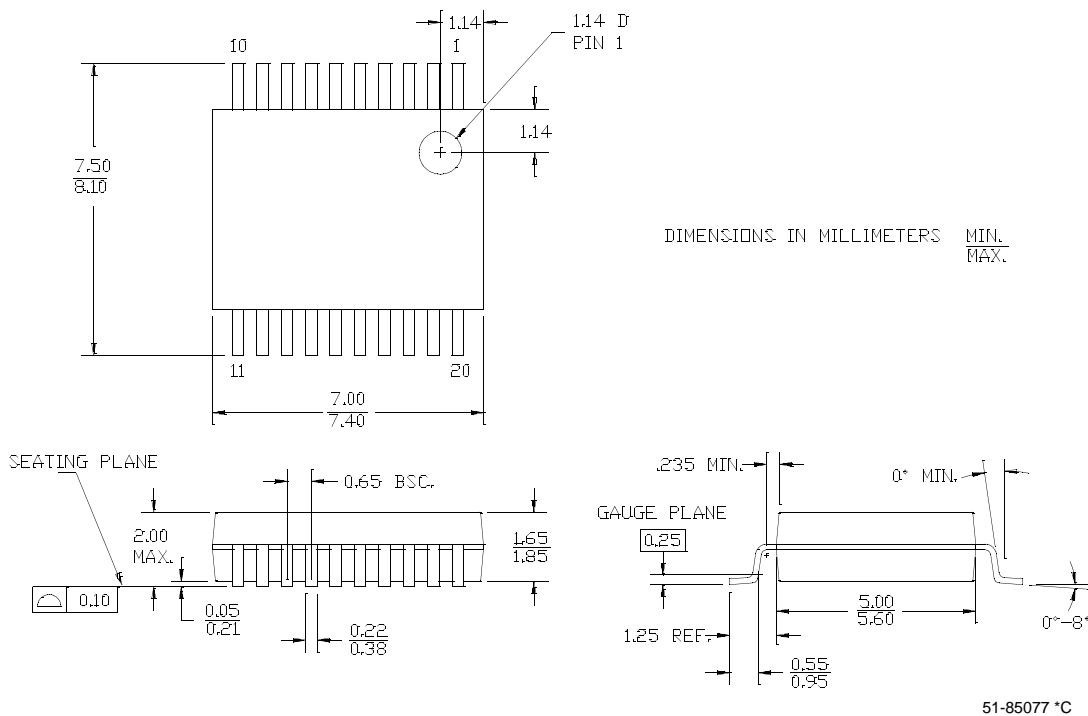


Figure 4-1. 20-Lead (210-Mil) SSOP

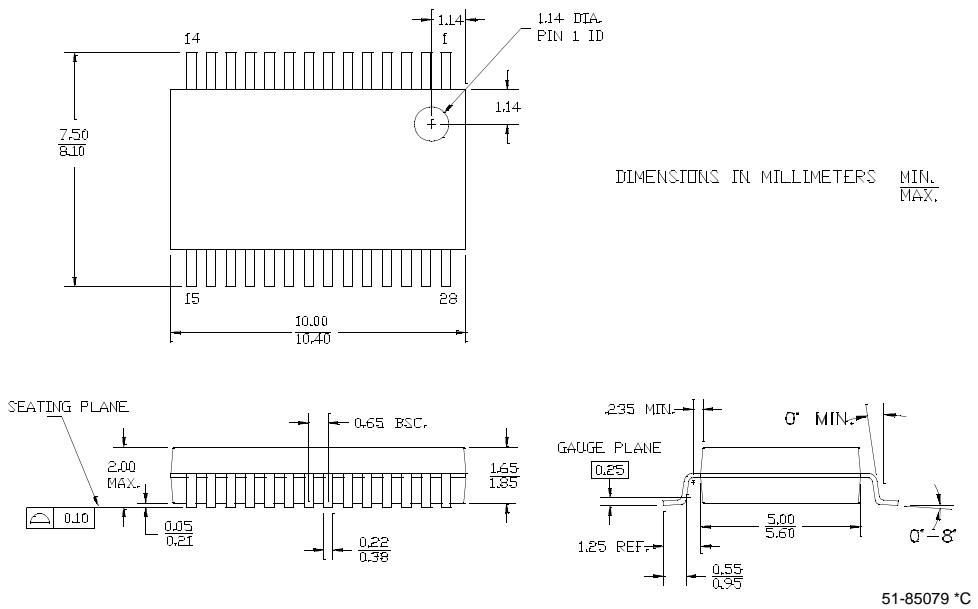


Figure 4-2. 28-Lead (210-Mil) SSOP

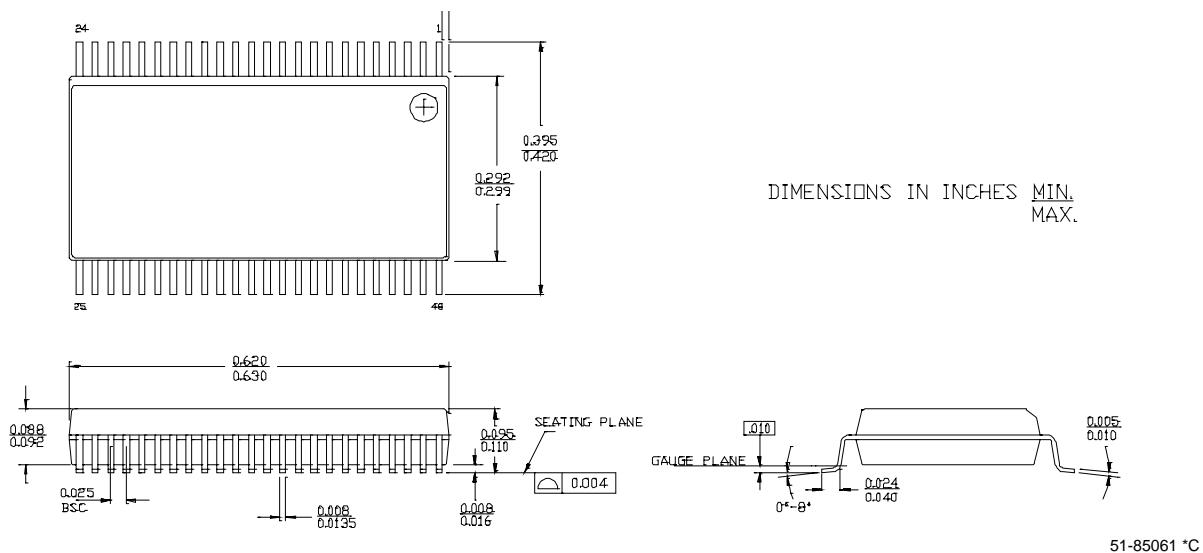


Figure 4-3. 48-Lead (300-Mil) SSOP

## 4.2 Thermal Impedances

Table 4-1. Thermal Impedances per Package

| Package | Typical $\theta_{JA}$ * |
|---------|-------------------------|
| 20 SSOP | 95 °C/W                 |
| 28 SSOP | 95 °C/W                 |
| 48 SSOP | 69 °C/W                 |

\*  $T_J = T_A + \text{POWER} \times \theta_{JA}$

## 4.3 Capacitance on Crystal Pins

Table 4-2: Typical Package Capacitance on Crystal Pins

| Package | Package Capacitance |
|---------|---------------------|
| 20 SSOP | 2.6 pF              |
| 28 SSOP | 2.8 pF              |
| 48 SSOP | 3.3 pF              |

## 4.4 Solder Reflow Peak Temperature

Following is the minimum solder reflow peak temperature to achieve good solderability.

Table 4-3. Solder Reflow Peak Temperature

| Package | Minimum Peak Temperature* | Maximum Peak Temperature |
|---------|---------------------------|--------------------------|
| 20 SSOP | 240°C                     | 260°C                    |
| 28 SSOP | 240°C                     | 260°C                    |
| 48 SSOP | 240°C                     | 260°C                    |

\*Higher temperatures may be required based on the solder melting point. Typical temperatures for solder are  $220 \pm 5^\circ\text{C}$  with Sn-Pb or  $245 \pm 5^\circ\text{C}$  with Sn-Ag-Cu paste. Refer to the solder manufacturer specifications.

# 5. Ordering Information



The following table lists the CY8C27x43 automotive PSoC device's key package features and ordering codes.

**Table 5-1. CY8C27x43 Automotive PSoC Key Features and Ordering Information**

| Package                               | Ordering Code     | Flash (Bytes) | RAM (Bytes) | Switch Mode Pump | Temperature Range | Digital Blocks | Analog Blocks | Digital IO Pins | Analog Inputs | Analog Outputs | XRES Pin |
|---------------------------------------|-------------------|---------------|-------------|------------------|-------------------|----------------|---------------|-----------------|---------------|----------------|----------|
| 20 Pin (210 Mil) SSOP                 | CY8C27243-12PVXE  | 16K           | 256         | No               | -40C to +105C     | 8              | 12            | 16              | 8             | 4              | Yes      |
| 20 Pin (210 Mil) SSOP (Tape and Reel) | CY8C27243-12PVXET | 16K           | 256         | No               | -40C to +105C     | 8              | 12            | 16              | 8             | 4              | Yes      |
| 28 Pin (210 Mil) SSOP                 | CY8C27443-12PVXE  | 16K           | 256         | No               | -40C to +105C     | 8              | 12            | 24              | 12            | 4              | Yes      |
| 28 Pin (210 Mil) SSOP (Tape and Reel) | CY8C27443-12PVXET | 16K           | 256         | No               | -40C to +105C     | 8              | 12            | 24              | 12            | 4              | Yes      |
| 48 Pin (300 Mil) SSOP                 | CY8C27643-12PVXE  | 16K           | 256         | No               | -40C to +105C     | 8              | 12            | 44              | 12            | 4              | Yes      |
| 48 Pin (300 Mil) SSOP (Tape and Reel) | CY8C27643-12PVXET | 16K           | 256         | No               | -40C to +105C     | 8              | 12            | 44              | 12            | 4              | Yes      |

## 5.1 Ordering Code Definitions

CY 8 C 27 xxx-SPxx

Package Type:  
PX = PDIP Pb-Free  
SX = SOIC Pb-Free  
PVX = SSOP Pb-Free  
LFX/LKX = QFN Pb-Free  
AX = TQFP Pb-Free

Thermal Rating:  
C = Commercial  
I = Industrial  
E = Extended

Speed: 12 MHz

Part Number

Family Code

Technology Code: C = CMOS

Marketing Code: 8 = Cypress PSoC

Company ID: CY = Cypress

# 6. Sales and Service Information



To obtain information about Cypress Semiconductor or PSoC sales and technical support, reference the following information.

## Cypress Semiconductor

198 Champion Court  
San Jose, CA 95134  
408.943.2600

Web Links: Company Information – <http://www.cypress.com>  
Sales – [http://www.cypress.com/aboutus/sales\\_locations.cfm](http://www.cypress.com/aboutus/sales_locations.cfm)  
Technical Support – <http://www.cypress.com/support/login.cfm>

## 6.1 Revision History

**Table 6-1. CY8C27x43 Automotive Data Sheet Revision History**

|   |   |                      |     |   |
|---|---|----------------------|-----|---|
| Document Title:   | CY8C27243, CY8C27443, and CY8C27643 Automotive PSoC Mixed-Signal Array Final Data Sheet |                      |     |   |
| Document Number:  | 38-12023  |                      |     |   |
| <b>Revision</b> <b>ECN #</b> <b>Issue Date</b> <b>Origin of Change</b> <b>Description of Change</b> |   |                      |     |   |
| **  | 211622  | 03/30/2004           | SFV | First release of the CY8C27x43 automotive PSoC device data sheet.   |
| *A  | 225728  | 06/01/2004           | SFV | Changes made to the Electrical Specifications chapter and Overview. Also changed title.   |
| *B  | 271469  | See ECN              | HMT | Update per SFV memo. Input MWR changes, including removing SMP. Change to Final.  |
| *C  | 286034  | See ECN              | HMT | Update characterization data. Fine tune pinouts. Add Reflow Peak Temp. table.   |
| *D  | 563653  | See ECN              | HMT | Add Low Power Comparator (LPC) AC/DC electrical spec. tables. Add CY8C20x34 to PSoC Device Characteristics table. Update Technical Training Modules paragraph. Add ISSP note to pinout tables. Update typical and recommended Storage Temperature per extended temp. specs. Update CY branding and QFN convention. Update copyright and trademarks. Swap 48-pin SSOP pins 45 and 46. Update links to new CY.com Portal. |
| <b>Distribution:</b> External Public  |   | <b>Posting:</b> None |     |   |

## 6.2 Copyrights and Flash Code Protection

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### Flash Code Protection

Note the following details of the Flash code protection features on Cypress Semiconductor PSoC devices.

Cypress Semiconductor products meet the specifications contained in their particular data sheets. Cypress Semiconductor believes that its family of products is one of the most secure families of its kind on the market today, regardless of how they are used. There may be methods, unknown to Cypress Semiconductor, that can breach the code protection features. Any of these methods, to our knowledge, would be dishonest and possibly illegal. Neither Cypress Semiconductor nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Cypress Semiconductor is willing to work with the customer who is concerned about the integrity of their code. Code protection is constantly evolving. We at Cypress Semiconductor are committed to continuously improving the code protection features of our products.



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